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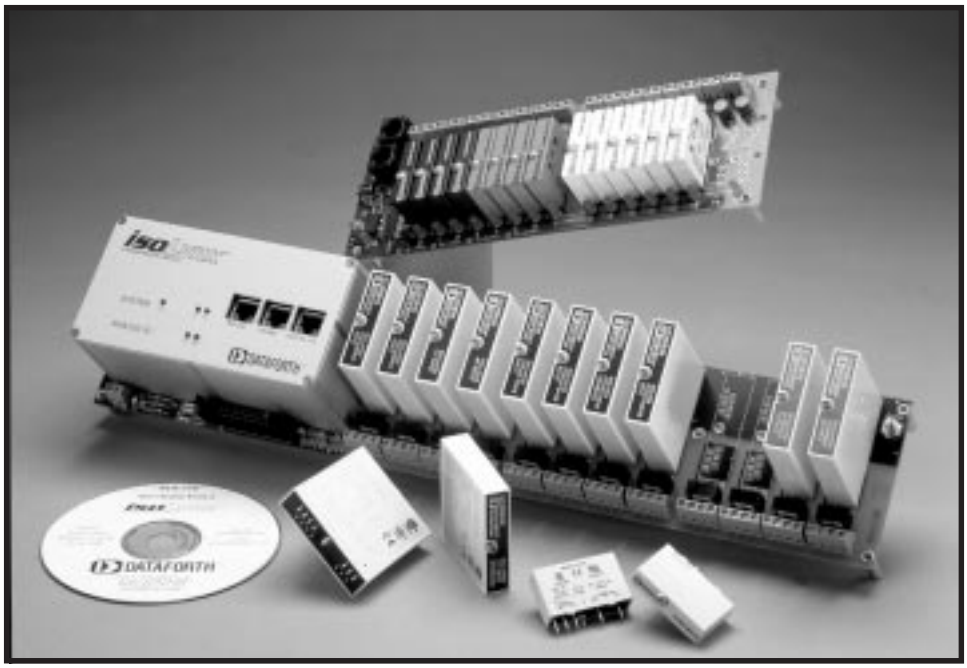
isoLynx™ Hardware User Manual



DATAFORTH®

isoLynx™ Hardware User Manual

isoLynx™ Hardware User Manual
MA1017 – January 2003

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About This Manual

This manual is organized as follows:

- Chapter 1: Inspection Guidelines
- Chapter 2: System Overview
- Chapter 3: Dimensions and Mounting Considerations
- Chapter 4: isoLynx™ Analog I/O Base Unit Description
- Chapter 5: Analog I/O Expansion Backpanels Description
- Chapter 6: isoLynx™ Digital I/O Backpanel Description
- Chapter 7: Computer – isoLynx™ Communications

Related Documents

The following documents contain additional information:

- *isoLynx™ Quick Start Guide*
- *isoLynx™ Software User Manual*

About Dataforth Corporation

"Our passion at Dataforth Corporation is designing, manufacturing, and marketing the best possible signal conditioning and data communication products. Our mission is setting new standards of product quality, performance, and customer service." Dataforth Corporation, with over 17 years experience, is the worldwide leader in Instrument Class™ Industrial Electronics – rugged, high performance signal conditioning and data communication products that play a vital role in maintaining the integrity of industrial automation, data acquisition, and quality assurance systems. Our products directly connect to most industrial sensors and protect valuable measurement and control signals and equipment from the dangerous and degrading effects of noise, transient power surges, internal ground loops, and other hazards present in industrial environments.

Dataforth spans the globe with over 50 International Distributors and US Representative Companies. Our customers benefit from a team of over 130 sales people highly trained in the application of precision products for industrial markets. In addition, we have a team of application engineers in our Tucson factory ready to address and solve any in-depth application questions. Upon receipt of a quote or order, our Customer Service Department provides fast one-day response of delivery information. We maintain an ample inventory that allows small quantity orders to be shipped from stock.

Contacting Dataforth Corporation

Contact Method	Contact Information
E-Mail: Technical Support:	*techinfo@dataforth.com*
Website:	*www.dataforth.com*
Phone:	520 741 1404 and 800 444 7644
Fax:	520 741 0762
Mail:	Dataforth Corporation 3331 E. Hemisphere Loop Tucson, AZ 85706

Errata Sheets

Refer to the Technical Support area of Dataforth's web site (*www.dataforth.com*) for any errata information on this product.

1.0 Inspection Guidelines

1.1 Unpacking

Each isoLynx™ Analog I/O Base Unit is shipped in electro-static discharge (ESD) protective packaging. Use appropriate ESD protection measures while unpacking. Check visually for physical damage. If physical damage is noted, file a claim with the shipping carrier.

1.2 isoLynx™ Analog I/O Base Unit Package Contents

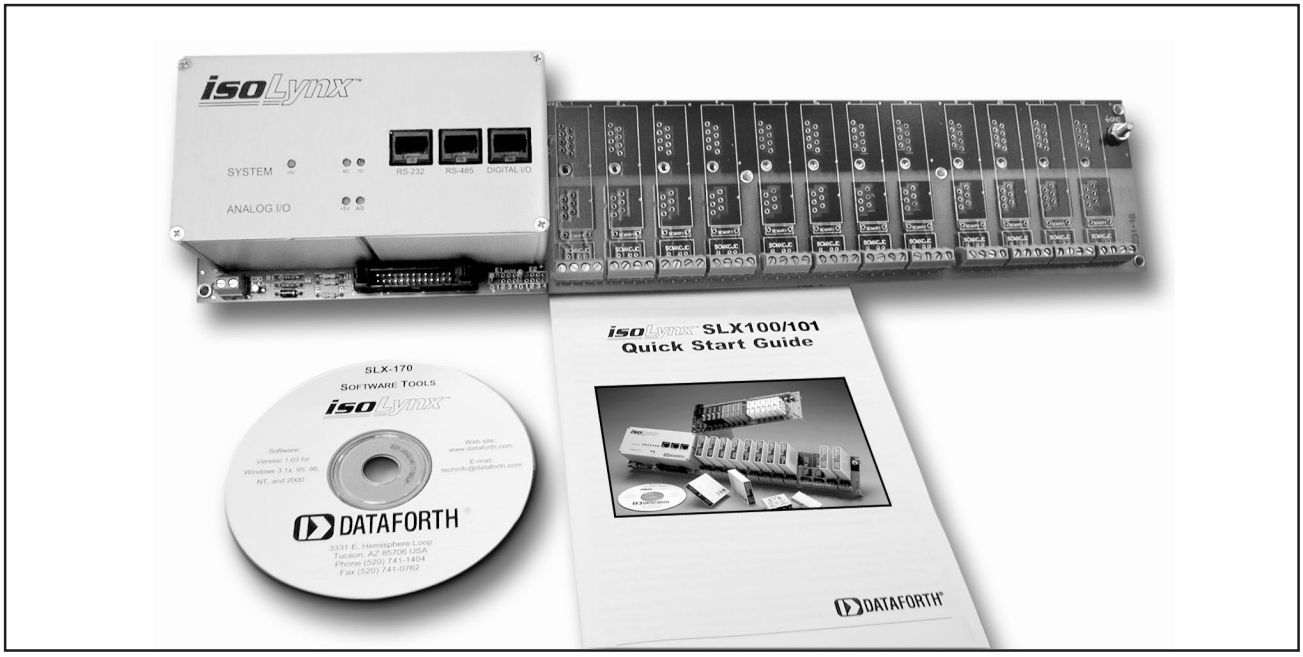

Figure 1.2-1

isoLynx™ SLX100 Analog I/O Base Unit comprised of:

- isoLynx™ Controller (containing one Processor Board, one I/O Signal Converter Board, and one Industrial Communication Board) mounted on the 12 channel Analog I/O Base Unit backpanel.
- One CD-ROM containing isoLynx™ data acquisition software drivers/examples and documentation files including: Help files, manuals, and specifications.
- An *isoLynx™ SLX100/101 Quick Start Guide.*

This completes the unpacking and visual inspection of the isoLynx™ Analog I/O Base Unit.

For rapid verification of basic functionality, reference the *isoLynx™ SLX100/101 Quick Start Guide*.

For detailed configuration and installation in your system, reference the subsequent sections in this *isoLynx™ Hardware User Manual* and/or the *isoLynx™ Software User Manual* on CD-ROM.

1.3 Analog I/O Expansion Backpanels Package Contents

1.3.1 SCMPB02, 16-Position Analog I/O Backpanel

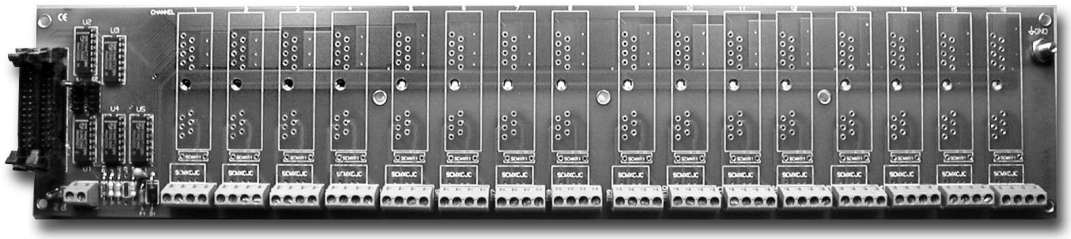

Figure 1.3.1-1

The SCMPB02 is shipped as a single fully assembled part. All backpanels include 16 module sites, 16 terminal blocks for field connections, expansion bus connectors, channel selection circuitry, addressing jumpers, power connection terminal block, power fuses, grounding options jumpers, and ground lug. Some options are: with or without cold junction compensation modules, with or without DIN Rail mounting brackets, depending on model ordered.

1.3.2 SCMPB06, 8-Position Analog I/O Backpanel

Figure 1.3.2-1

The SCMPB06 is shipped as a single fully assembled part. All backpanels include 8 module sites, 8 terminal blocks for field connections, expansion bus connectors, channel selection circuitry, addressing jumpers, power connection terminal block, power fuses, grounding options jumpers, and ground lug. Some options are: with or without cold junction compensation modules, with or without DIN Rail mounting brackets, depending on model ordered.

1.4 isoLynx™ Digital I/O Backpanel Package Contents

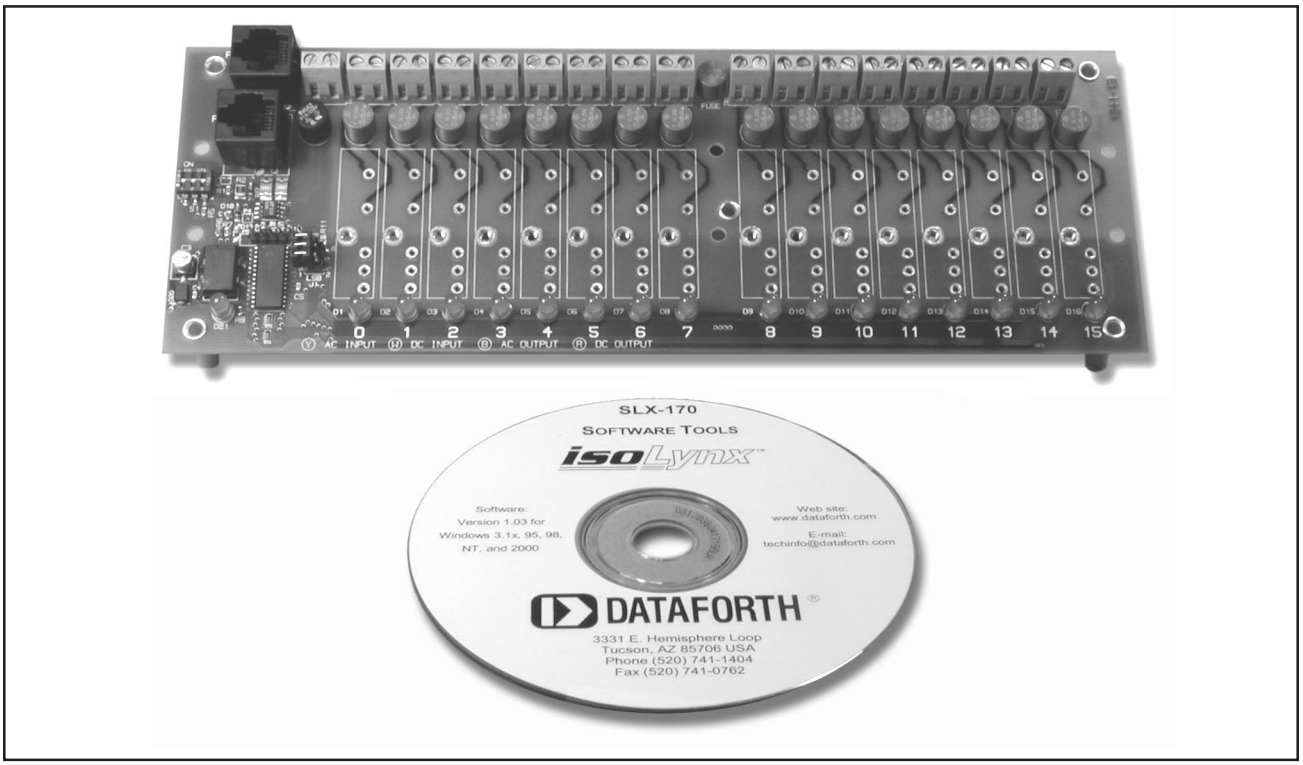

Figure 1.4-1

- isoLynx™ SLX101 Digital I/O Backpanel, containing two high speed serial I/O ports and 16 digital I/O channel module sockets.

- One CD-ROM containing isoLynx™ data acquisition software drivers/examples and documentation files including: Help files, manuals, and specifications.

This completes the unpacking and visual inspection of the isoLynx™ Digital I/O Backpanel.

For rapid verification of basic functionality, reference the *isoLynx™ SLX100/101 Quick Start Guide*. The scope of the *isoLynx™ SLX100/101 Quick Start Guide* covers rapid verification of the isoLynx™ Digital I/O Backpanel connected to an isoLynx™ Analog I/O Base Unit only.

For detailed configuration and installation in your system and for stand-alone operation, reference the subsequent sections in this *isoLynx™ Hardware User Manual* and/or the *isoLynx™ Software User Manual* on CD-ROM.

2.0 System Overview

The isoLynx is a fast, intelligent, fully isolated data acquisition system providing superior reliability, accuracy, and isolation for a wide range of rugged industrial applications. The flexible, modular design combines a 12-channel I/O Controller base system and optional 8- and 16-channel expansion backpanels. One I/O Controller module can operate up to 60 channels of analog I/O and 128 channels of digital I/O, using Dataforth's popular SCM5B analog and SCMD digital modules.

The isoLynx communicates on RS-232/485 serial links up to 115.2kbps, and/or Ethernet. Standard communication is RS-232/485 and up to 16 systems can be multi-dropped on the RS-485 serial link. Optional filedbus protocol communication boards are factory installed, but are field replaceable or upgradeable without processor hardware re-configuration.

2.1 Easy Installation

The isoLynx' compact footprint (17.4" x 3.5") allows it to easily fit into cramped system designs. Using the SCMXRK metal bracket, you can easily mount it in a rack. Alternatively, by ordering DIN Rail hardware elements, you can just as easily mount it on a DIN Rail.

2.2 Easy Connectivity

2.2.1 RS-232

Connecting RS-232 is as easy as clicking an RJ-45 modular phone plug into a modular phone jack at the isoLynx end and then clicking an RJ-45 modular phone plug into a modular phone jack at the host computer end if so equipped. Alternatively, you can click the RJ-45 modular phone plug into a modular phone jack in a DB-9 connector adapter, subsequently, plugging the DB-9 connector end into the host computer port. Refer to section 7.2 RS-232 Communications and Connections for information on how this connector is wired.

2.2.2 RS-485

Connecting RS-485 is as easy as clicking an RJ-45 modular phone plug into a modular phone jack at the isoLynx end and then clicking an RJ-45 modular phone plug into a modular phone jack at the host computer end if so equipped. Alternatively, you can click the RJ-45 modular phone plug into a modular phone jack in a DB-9 connector adapter, subsequently, plugging the DB-9 connector end into the host computer port. If required by your installation, you will set a few termination DIP switches and then you will be off and communicating. Refer to section 7.3 RS-485 Communications and Connections for information on how this connector is wired.

2.2.3 Ethernet

An Ethernet interface connection is one of the networking interfaces that can occupy the Industrial Communication Board position of the isoLynx Controller. Connecting to Ethernet is as easy as clicking an RJ-45 modular phone plug into a modular phone jack at the isoLynx end and then clicking an RJ-45 modular phone plug into a modular phone jack at the Ethernet hub or host computer if so equipped. Alternatively, you can click the RJ-45 modular phone plug into a modular phone jack in a DB-9 connector adapter, subsequently, plugging the DB-9 connector end into the Ethernet hub or the host computer port. Refer to section 7.4 Ethernet Communications and Connections for information on how this connector is wired.

2.2.4 To Digital I/O Backpanels

Connecting Digital I/O Backpanels is as easy as clicking an RJ-45 modular phone plug into a modular phone jack at the isoLynx end and then clicking an RJ-45 modular phone plug into a modular phone jack on the Digital I/O Backpanel. If required by your installation, you will set a few termination DIP switches and then you will be off and running digital I/O. Refer to section 4.1.3.2 Processor Board, Digital I/O Expansion Network

Termination Network Switches and section 6.2 Expansion Considerations, Expansion Network Connectors (P1, P2) and Expansion Network Termination Network Switches.

2.2.5 To Analog I/O Expansion Backpanels

Connecting Analog I/O Expansion Backpanels is as easy as setting a few address jumpers and then connecting an extension ribbon cable between the isoLynx Analog I/O Base Unit Backpanel and the Analog I/O Expansion Backpanel.

3.0 Dimensions and Mounting Considerations

The various models of the isoLynx system and expansion components have a choice of mounting options. Each can be mounted on a rack with the SCMXRK-002 19 inch metal mounting rack, onto a DIN Rail with available DIN Rail mounting elements, or through holes in swaged standoffs to a flat surface such as a NEMA-rated electrical enclosure. Sections 3.1 through 3.3 and their associated figures describe the isoLynx system and expansion components dimensions and mounting options. Select a mounting location that protects against the following environmental hazards:

- Avoid flying metal chips that may result from installation or subsequent machine construction. Avoid conductive dusts, liquids, or condensing humidity. If any of these conditions exist, mount the isoLynx system and expansion components in a NEMA 4 or NEMA 12 rated enclosure.

- Do not mount the isoLynx system and expansion components in an environment that requires explosion proof practices.

- Avoid mounting locations that are in close proximity to devices that produce Electro-Magnetic Interference (EMI) or Radio Frequency Interference (RFI). Devices such as motor starters, relays, large power transformers, and ultrasonic welding apparatus fall into this category.

3.1 isoLynx™ Analog I/O Base Unit

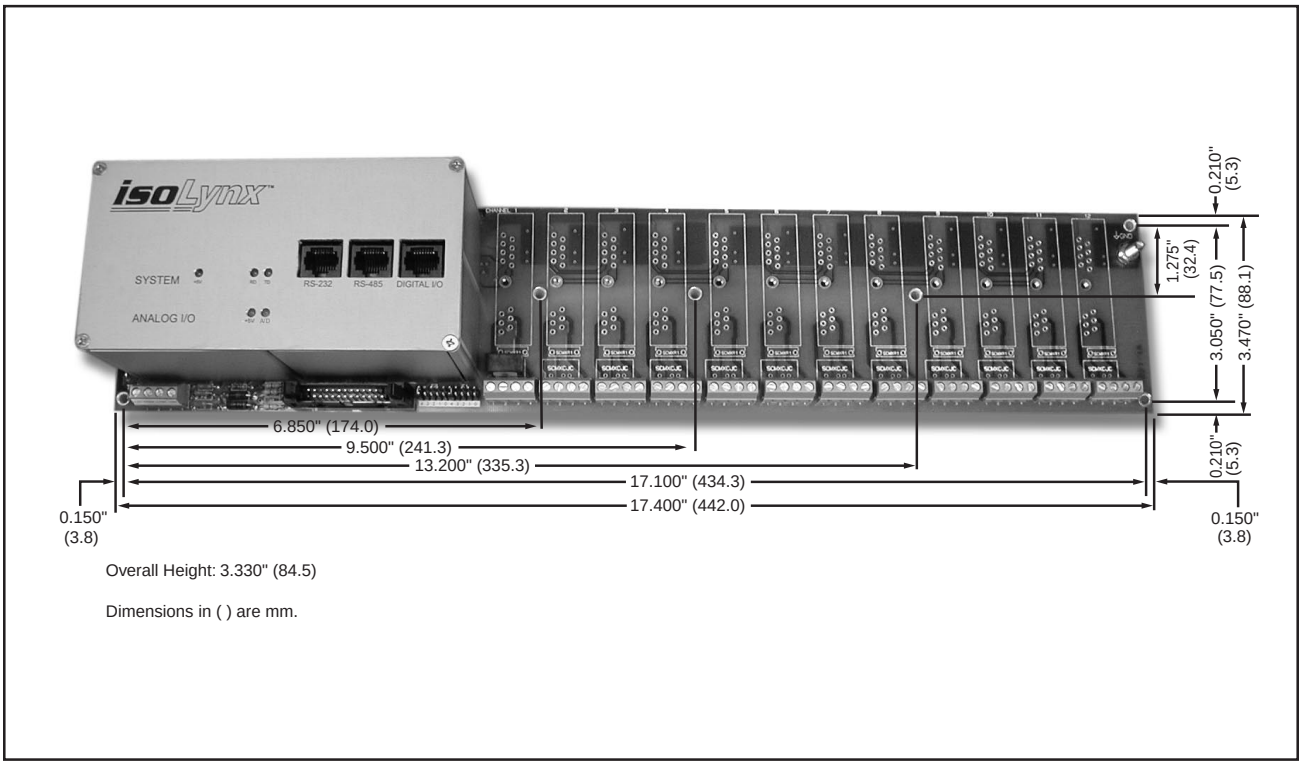

Figure 3.1-1

3.2 Analog I/O Expansion Backpanels

3.2.1 SCMPB02, 16-Position Analog I/O Backpanel

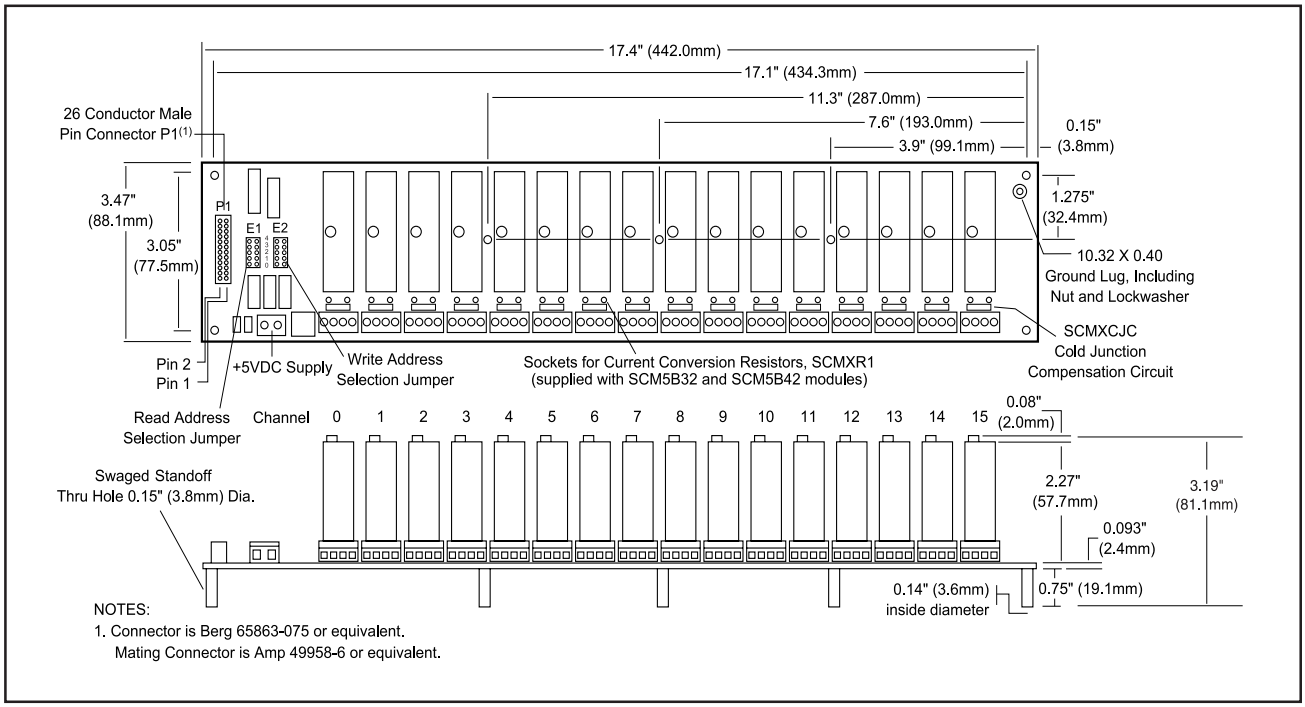

Figure 3.2.1-1

3.2.2 SCMPB06, 8-Position Analog I/O Backpanel

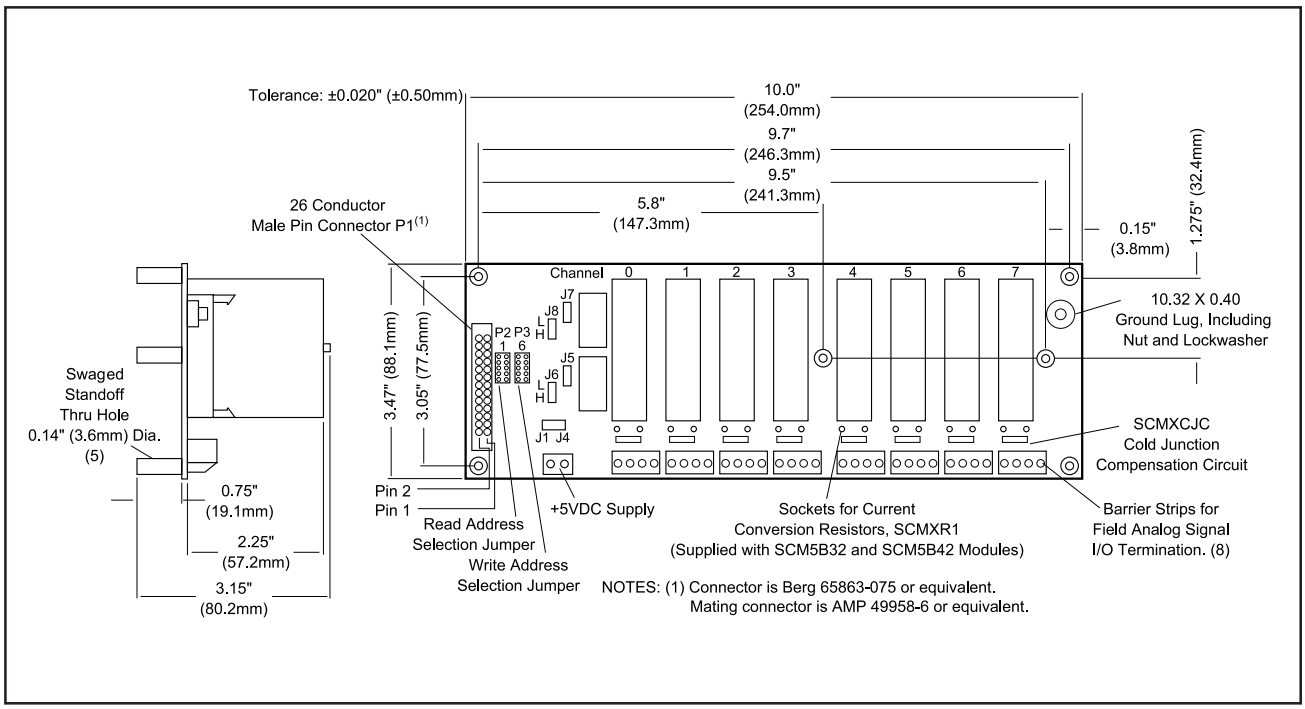

Figure 3.2.2-1

3.3 isoLynx™ Digital I/O Backpanel

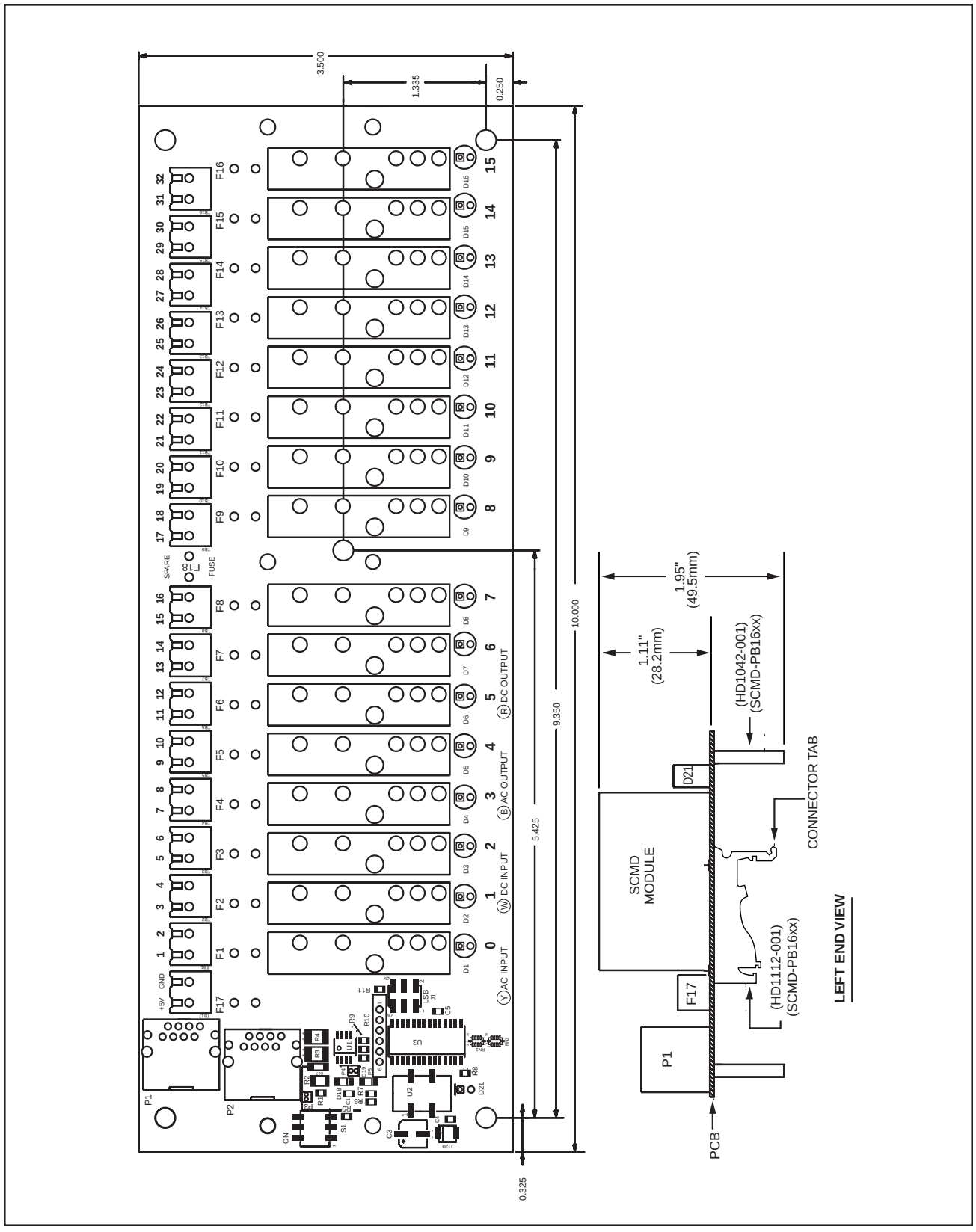

Figure 3.3-1

4.0 isoLynx™ Analog I/O Base Unit Description

4.1 isoLynx™ Controller

4.1.1 Indicators and Connectors

4.1.1.1 Industrial Communication Board

Ethernet - LEDs

The Ethernet Board LEDs are: +5V, LNK, and ACT. The +5V LED indicates that the Ethernet board is properly powered with 5VDC. LNK indicates that the signal connected to the Ethernet board is an Ethernet signal and that it is a good connection. ACT indicates that the Ethernet link is active with data.

Figure 4.1.1.1-1

Ethernet - Connector

The Ethernet connector is an RJ-45 modular phone jack. The Ethernet connection should always be made using a Category 5 twisted-pairs cable such as SLX141-xx or equivalent. Refer to section 7.4 for pinout listings and more information on connectors and cabling for Ethernet.

4.1.1.2 Processor Board

LEDs

The Processor Board LEDs are: +5V, RD, and TD. The +5V LED indicates that the Processor Board is properly powered with 5VDC. RD and TD indicate Receive Data and Transmit Data, respectively, for any serial I/O data communications.

Figure 4.1.1.2-1

Connectors

The Processor Board connectors are: RS-232, RS-485, and SLX101 isoLynx Digital I/O Backpanel interface. All interface connectors are RJ-45 modular phone jacks. The RS-232 interface connection can be made using a variety of cables from 8-conductor flat cable through Category 3 to Category 5 twisted-pairs cable. The RS-485 and SLX101 isoLynx Digital I/O Backpanel expansion network connection can be made using Category 3 to Category 5 twisted-pairs cable.

Dataforth offers SLX141-02,-03, and -05 Category 5 cable in three fixed lengths 2, 3, and 5 meters, respectively. Also available are the SLX142-P or –S RJ-45 (EIA-561) to DB-9 (EIA-574) RS-232 adapter and the SLX143-P or –S RJ-45 to DB-9 uncommitted adapter to be wired to the user's DB-9 pinout. Refer to sections 7.2 and 7.3 for pinout listings for RS-232 and RS-485.

4.1.1.3 I/O Signal Converter Board

LEDs

Figure 4.1.1.3-1

The I/O Signal Converter Board LEDs are: +5V and A/D. The +5V LED indicates that the I/O Signal Converter Board is properly powered with 5VDC. The A/D LED indicates various states of operation of the isoLynx system. If the isoLynx micro controller detected a hardware failure during power on self test, the A/D LED signals the failure type through blink patterns. If the isoLynx hardware passed the power on self test, the A/D LED will blink at a steady rate. This steady rate blinking shows that A/D and D/A conversions are occuring and inputs are being read and outputs are being refreshed on a repetitive basis. Appendix A.1 describes A/D LED blink patterns in greater detail.

4.1.2 Opening the isoLynx Controller, Identifying Boards

Figure 4.1.2-1

NOTE: A grounded static dissipative strap should be worn for this operation.

Turn off power to the isoLynx Analog I/O Base Unit Backpanel and disconnect all cables from the top of the isoLynx Controller. It may now be opened by removing the phillips flat head screws holding the top plate in place. There are six screws, four at the corners and two at the sides midway between the ends. Once the screws are removed lift the top plate carefully until it clears the connectors and LEDs. This will expose the boards inside. Figure 4.1.2-2 indicates the boards with names.

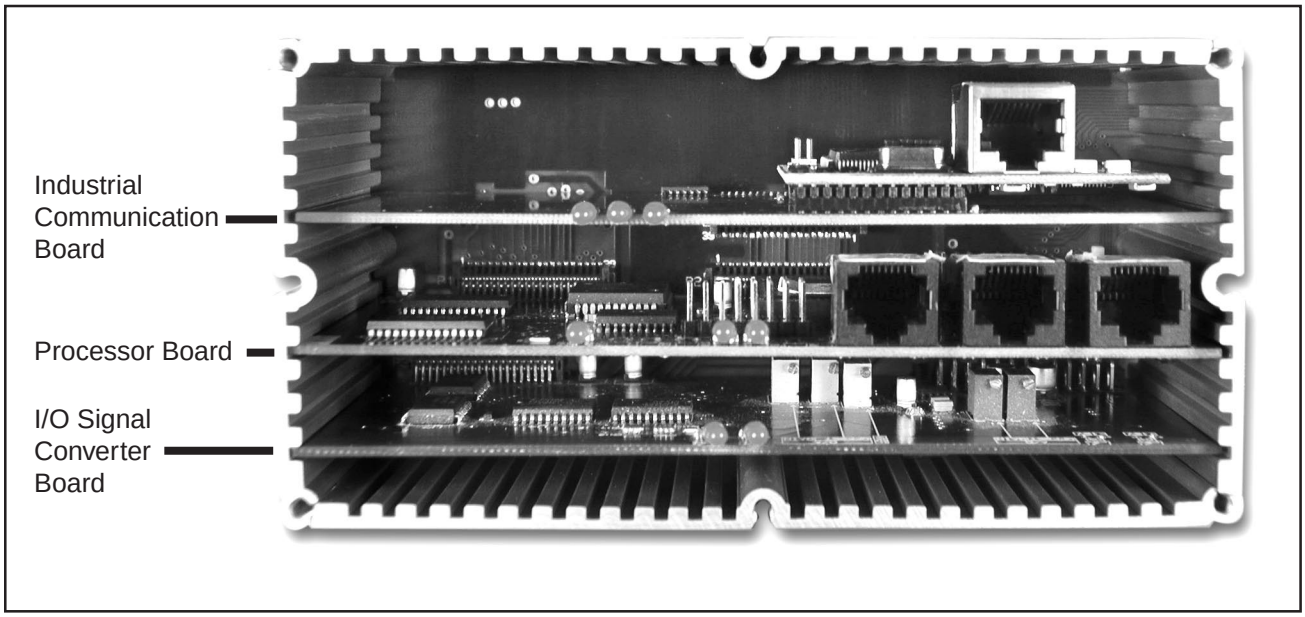

Figure 4.1.2-2

4.1.3 Removing and Replacing Boards

NOTE: A grounded static dissipative strap should be worn for this operation.

4.1.3.1 Industrial Communication Board

With the isoLynx Analog I/O Base Unit in the same orientation as in Figure 4.1.2-1 grasp the left and right edges of the Industrial Communication Board and pull straight up until the board clears the top edge of the enclosure, any LEDs, and connectors. To replace, find the slot whose bus connectors on the backpanel match those on the Industrial Communication Board. Slide the board down the slot until the connectors just engage. Then push the board until the connectors fully engage.

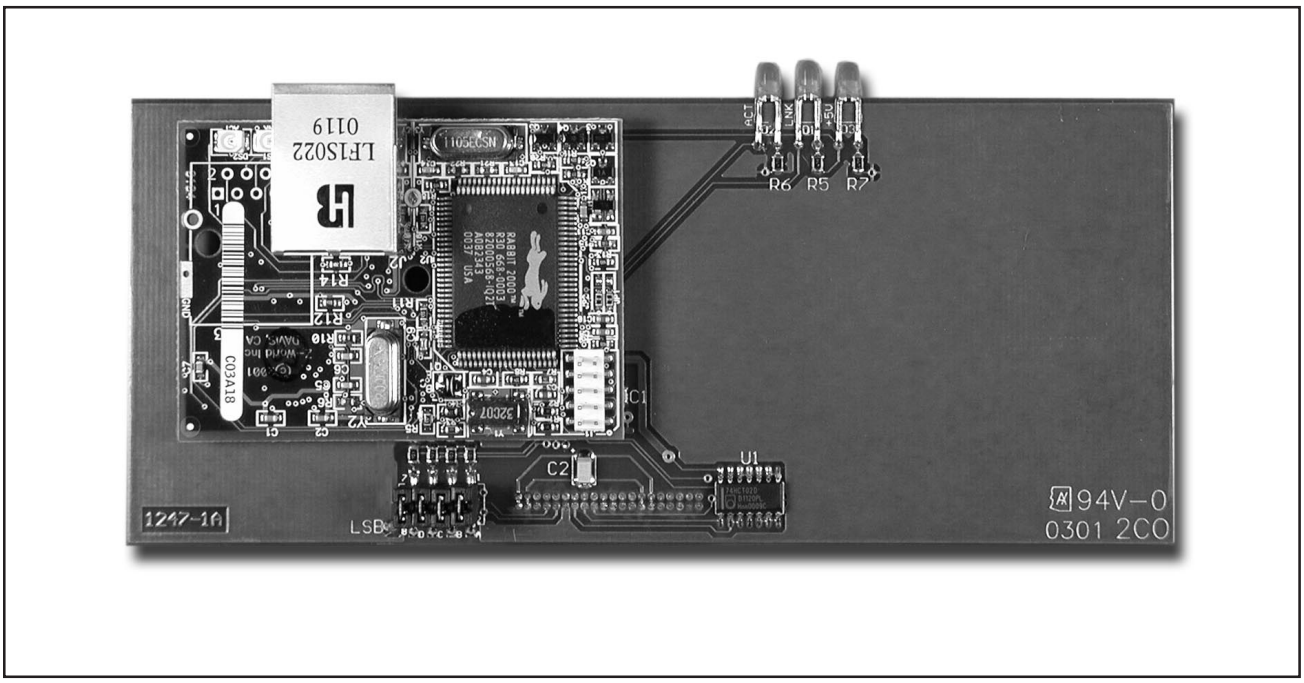

Figure 4.1.3.1-1

A description and photograph of the Ethernet Industrial Communication Board are here for completeness only. The board requires no user settings. The jumpers defining the network type are preset at the factory.

Field Installation Instructions

NOTE: A grounded static dissipative strap should be worn for this operation.

If at some point you decided to switch network types to Ethernet, you will have the SLX120 Ethernet Communication Board field install kit. At this point in the *isoLynx™ Hardware User Manual* the isoLynx Controller top plate is off. If not, remove it.

Find the slot whose bus connectors on the backpanel match those on the Industrial Communication Board (refer to Figure 4.1.2-1). Slide the board down the slot until the connectors just engage. Then push the board until the connectors fully engage. Use the top plate which is in the field install kit. This completes the SLX120 Ethernet Communication Board hardware field installation.

Refer to the *isoLynx™ Software User Manual*, section 2.10.4 “Changing from RS-485 2-wire to Ethernet and back”, to configure the isoLynx System for Ethernet operation.

If for any reason, you need to redeploy an Ethernet enabled isoLynx in an RS-485 network, remove the Ethernet top plate. Remove the Ethernet Industrial Communications board and store it. Install the RS-485 top plate. Then refer to the *isoLynx™ Software User Manual*, section 2.10.4 “Changing from RS-485 2-wire to Ethernet and back”, to configure the isoLynx System for RS-485 2-wire operation. Begin reading the last half of the section starting at “Later,”.

4.1.3.2 Processor Board

With the isoLynx Analog I/O Base Unit in the same orientation as in Figure 4.1.2-1 grasp the left and right edges including the RJ-45 connector of the Processor Board and pull straight up until the board clears the top edge of the enclosure, any LEDs, and connectors. To replace, find the slot whose bus connectors on the backpanel match those of the Processor Board. Slide the board down the slot until the connectors just engage. Then push the board until the connectors fully engage.

RS-485 Termination Networks Switches

In general for RS-485 for trunk line lengths over 100 ft (30.5 m), the two devices at the extreme ends of the trunk line should be terminated and all other devices in between should not. The Processor Board offers built-in termination networks for 2-wire or 4-wire networks accessed through DIP switches. The location of the RS-485 termination DIP switches are identified in Figure 4.1.3.2-1.

Two-wire Networks

DIP switch, S1, sections 1 through 3 are used for 2-wire networks and sections 4 through 6 should be switched off (the actuators away from ON). Section 1 switches in a pull-down resistor for the A line of the differential signal. Section 3 switches in a pull-up resistor for the B line of the differential signal. The pull-down pull-up network provides the idle line biasing for the RS-485 input. Section 2 switches the line impedance terminating resistor across the differential signal. In most cases, the installation will require sections 1 through 3 all to be switched to ON (termination network in). Some cases may allow fewer or no terminating elements to be in the network. This can be determined by a little experimentation; use the combination of elements which give the most reliable data transfer. Then document the settings.

The factory default settings are: sections 1 through 3 are ON and sections 4 through 6 are OFF. These are also the end of trunk line settings for RS-485 2-wire networks.

For proper termination of all RS-485 devices in a 2-wire multidrop network, reference the application note in Appendix D - AN302 isoLynx™ RS-485 and Digital I/O Expansion Network Configurations.

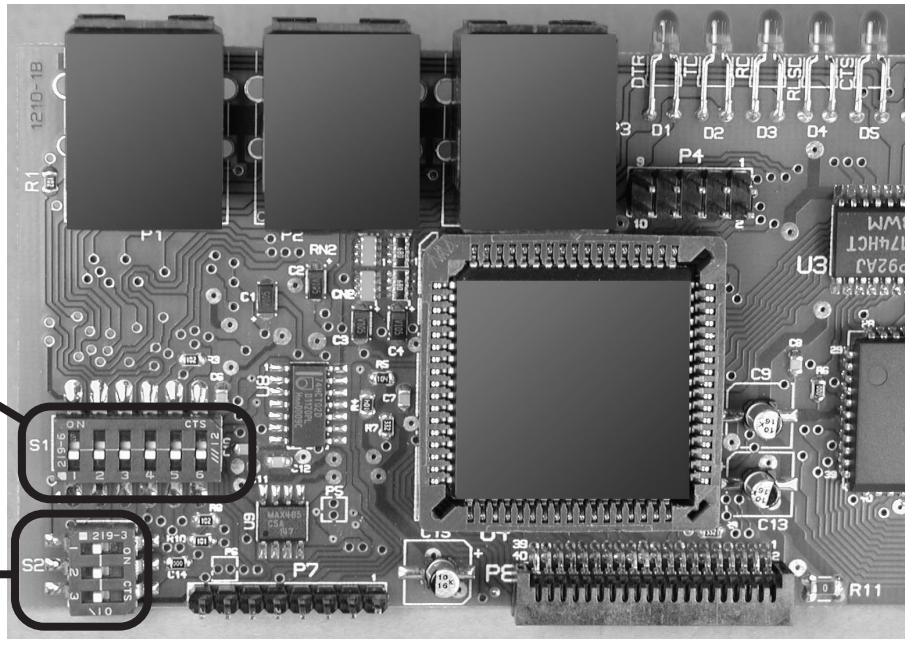

Figure 4.1.3.2-1

Four-wire Networks

DIP switch, S1, sections 2 and 4 through 6 are used for 4-wire networks and sections 1 and 3 should be switched off (the actuators away from ON). Section 2 switches the line impedance terminating resistor across the Transmit Data (TD) differential signal. Section 4 switches in a pull-down resistor for the A line of the differential signal. Section 6 switches in a pull-up resistor for the B line of the differential signal. The pull-down pull-up network provides the idle line biasing for the RS-485 input. Section 5 switches the line impedance terminating resistor across the differential signal. In most cases, the installation will require sections 2 and 4 through 6 all to be switched to ON (termination network in). Some cases may allow fewer or no terminating elements to be in the network. This can be determined by a little experimentation; use the combination of elements which give the most reliable data transfer. Most installations will require the terminating resistor in section 5 because it terminates the receiver which is the most sensitive node. Then document the settings.

The factory default settings are: sections 1 through 3 are ON and sections 4 through 6 are OFF. These are also the end of trunk line settings for RS-485 2-wire networks.

For proper termination of all RS-485 devices in a 4-wire multidrop network, reference the application note in Appendix D - AN302 isoLynx™ RS-485 and Digital I/O Expansion Network Configurations.

Digital I/O Expansion Network Termination Network Switches

In general for differential trunk line lengths over 100 ft (30.5 m), the two devices at the extreme ends of the trunk line should be terminated and all other devices in between should not. The Processor Board offers a built-in termination network for the 2-wire Digital I/O network accessed through DIP switches. The location of the Digital I/O termination DIP switches are identified in Figure 4.1.3.2-1.

DIP switch, S2, sections 1 through 3 are used for the 2-wire Digital I/O expansion network. Section 1 switches in a pull-down resistor for the A line of the differential signal. Section 2 switches in a pull-up resistor for the B line of the differential signal. The pull-down pull-up network provides the idle line biasing for the differential input. Section 3 switches the line impedance terminating resistor across the differential signal. In most cases, the installation will require sections 1 through 3 all to be switched to ON (termination network in). Some cases may allow fewer or no terminating elements to be in the network. This can be determined by a little experimentation; use the combination of elements which give the most reliable data transfer. Then document the settings.

The factory default settings are: sections 1 through 3 are ON. These are also the end of trunk line settings for RS-485 2-wire networks.

For proper termination of all RS-485 devices in a 2-wire multidrop isoLynx Digital I/O Expansion Network, reference the application note in Appendix D - AN302 isoLynx™ RS-485 and Digital I/O Expansion Network Configurations.

4.1.3.3 I/O Signal Converter Board

With the isoLynx Analog I/O Base Unit in the same orientation as in Figure 4.1.2-1 grasp the left and right edges of the I/O Signal Converter Board and pull straight up until the board clears the top edge of the enclosure, any LEDs, and connectors. To replace, find the slot whose bus connectors on the backpanel match those of the I/O Signal Converter Board. Slide the board down the slot until the connectors just engage. Then push the board until the connectors fully engage.

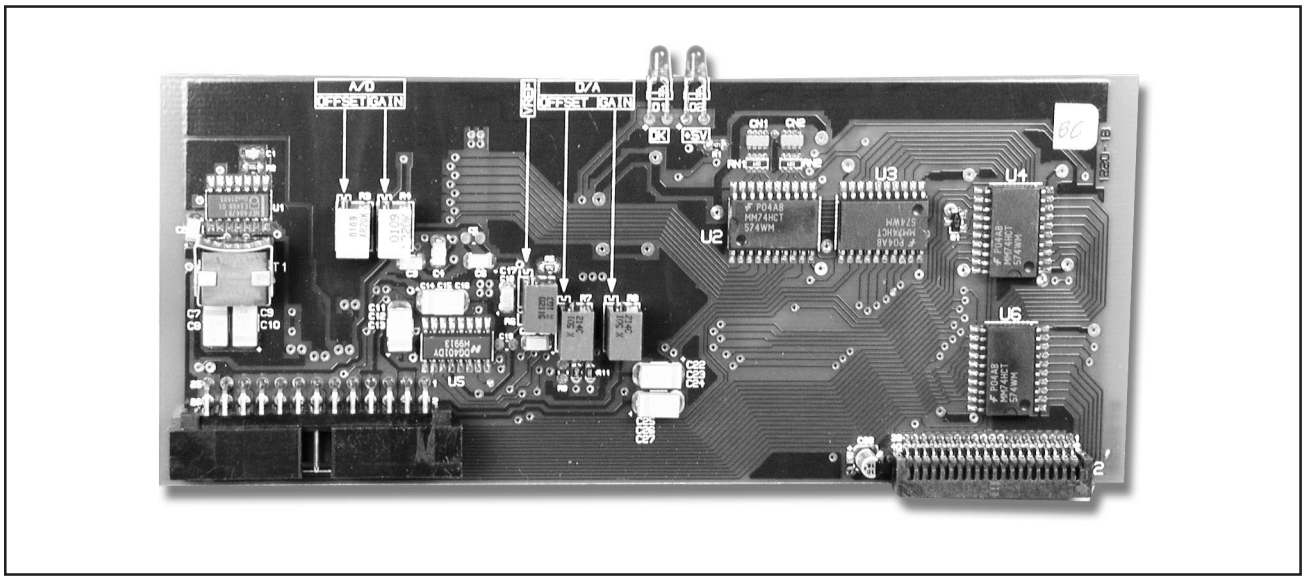

Figure 4.1.3.3-1

A description and photograph of the I/O Signal Converter Board are here for completeness only. The board requires no user adjustments. All trimpot adjustments are made for the requirements of the particular circuit component mix at the factory.

4.2 isoLynx™ Analog I/O Base Unit Backpanel

4.2.1 SCM5B Modules

Installation

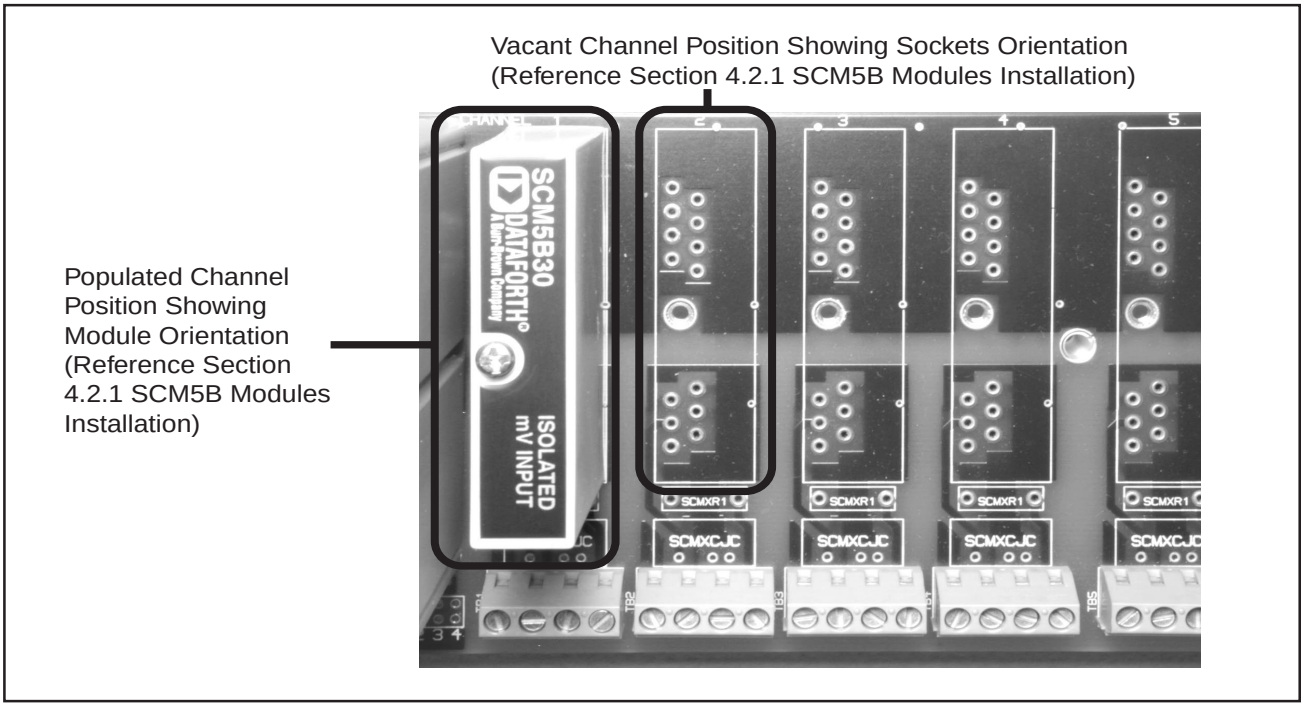

Figure 4.2.1-1

Each channel position on the backpanel has 14 sockets and a threaded insert. An SCM5B module plugs in only one way into the socket pattern. The module has a captive fastening screw which may be tightened into the threaded insert.

Wiring

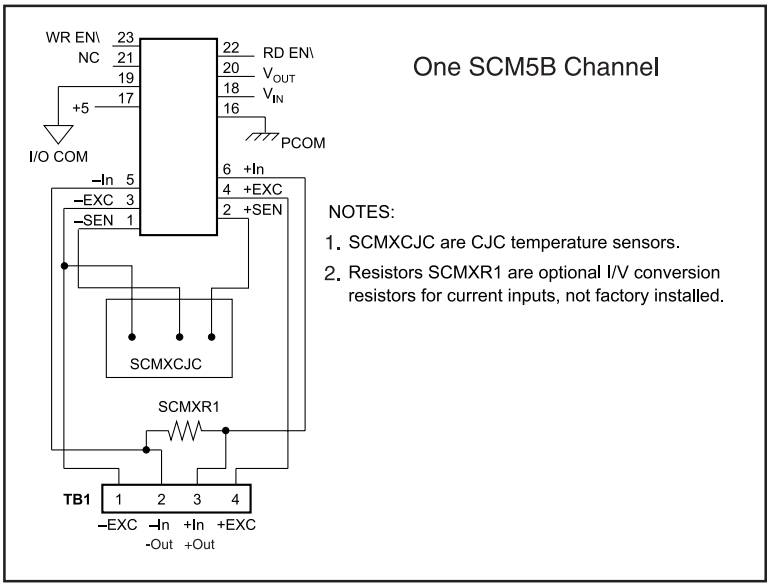

Figure 4.2.1-2

Field connections are made through the screw terminal blocks in front of the channel positions on the backpanel (TB1 – TB12). Figure 4.2.1-2 schematic shows the functions of the electrical connections.

4.2.2 Expansion Considerations

Network Address Selection

The jumpers outlined in Figure 4.2.2-1 to the right of the E1 and E2 jumpers select the isoLynx network address in a multidropped RS-485 network (for more on this, refer to section 4.1.3.2 and appendix D).

There are four jumpers which allow for 16 addresses. The LSB (Least Significant Bit) of the address lines is the jumper designated LSB on the board. A jumper over both pins of any jumper position corresponds to a 0 (zero) in the address and an open (a jumper over one pin) in any jumper position corresponds to a 1 (one) in the address. To obtain a particular address, just arrange jumpers in the binary weighted pattern of the hexadecimal value desired.

The factory default setting is address 0 – all jumpers set.

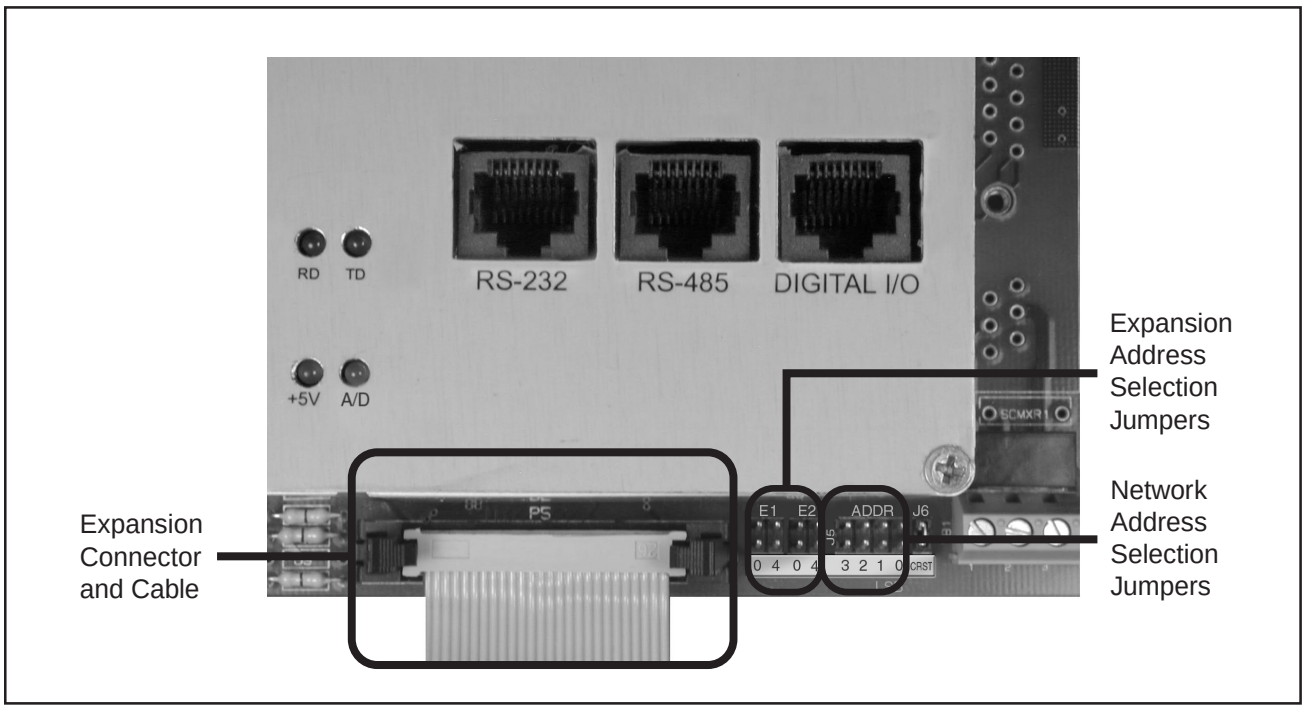

Figure 4.2.2-1

Backpanel Address Selection

The isoLynx Analog I/O Base Unit Backpanel has address decoding circuitry to allow multiplexing any combination of up to 12 input or output modules. Capability is also provided in the address decode circuitry to expand the system to 60 channels (one isoLynx Analog I/O Base Unit Backpanel + three SCMPB02/06 backpanels) of multiplexed input or output. The isoLynx Analog I/O Base Unit always resides at the base addresses 0-11. Therefore, E1 and E2 have only two positions each, one for stand alone operation and one for expanded operation. Channels 12-15 are not available in an isoLynx system.

The table below shows the correlation of jumper position to address range. The factory default settings are: E1, 4 is open and 0 is set; E2, 4 is open and 0 is set.

E1 Jumper Pos	**E2 Jumper Pos**	**Address Range/Mode**
4	4	0-11, STAND ALONE
0	0	0-11, EXPANDED

To connect to multiple SCMPB02/06 backpanels in this expanded configuration, use interconnect cable SCMXCA004-XX. Refer to sections 5.1.2 and 5.2.2 for details on SCMPB02 and SCMPB06 expansion procedures.

Expansion Connector (P6)

The 26 pin connector P6 provides the signal interface between the isoLynx Analog I/O Base Unit Backpanel and the SCMPB02/06 backpanels. Two separate analog buses are provided; one for analog input signals and one for analog output signals. Two sets of six address lines and an enable pin allow input and output modules to be independently multiplexed onto their respective analog signal bus. R0 thru R5 and RDENAB are used for input modules, and W0 thru W5 and WRENAB are used for output modules.

4.2.3 Grounding Considerations

Backpanel Jumpers

Figure 4.2.3-1

For proper operation of the output switch or track-and-hold circuit when using the isoLynx Analog I/O Base Unit Backpanel, a current path must exist between the host control logic power common and module I/O Common (module pin 19). This path can be established on the isoLynx Analog I/O Base Unit Backpanel via jumper J4. If this connection exists elsewhere in the system, jumper J4 should be removed since possible ground loops could exist. Other connections of power ground and signal ground usually occur at the A/D or D/A converter of the host measurement system. More information on grounding can be found in Appendix C.1 - AN301 SCM5B-isoLynx™ Ground Connections.

If the connection of power common and SIG COM shield wires exist in the host measurement system, a resistive connection between SIG COM and the backpanel signal ground can be made via R1. R1 can be as large as 10K ohms; 100 ohms is a recommended value.

Grounding Stud

Figure 4.2.3-2

For full protection against large electrical disturbances on the field-side of the SCM5B modules, a #10-32 ground stud is provided on the backpanel. An electrical connection between this ground stud and system ground should be provided with a large gauge wire of the shortest possible length. When this connection is made, a possible ground loop could result through the SIG COM shield wires and backpanel signal ground. If the application involves only input modules and a differential input is used by the host measurement system, J1 should be removed. Remember that J1 is required if output modules are used or if the host system does not have differential inputs.

4.2.4 Power Considerations

Power Supply, Connector, and LED

The isoLynx Analog I/O Base Unit Backpanel requires external +5VDC ±5% power. The chassis mounted SLX160 power supply has adequate capacity to power any combination of modules. The power connection is made through the two position screw terminal block as shown in Figure 4.2.4-1. The LED shown in Figure 4.2.4-1 lights when a proper power connection has been made.

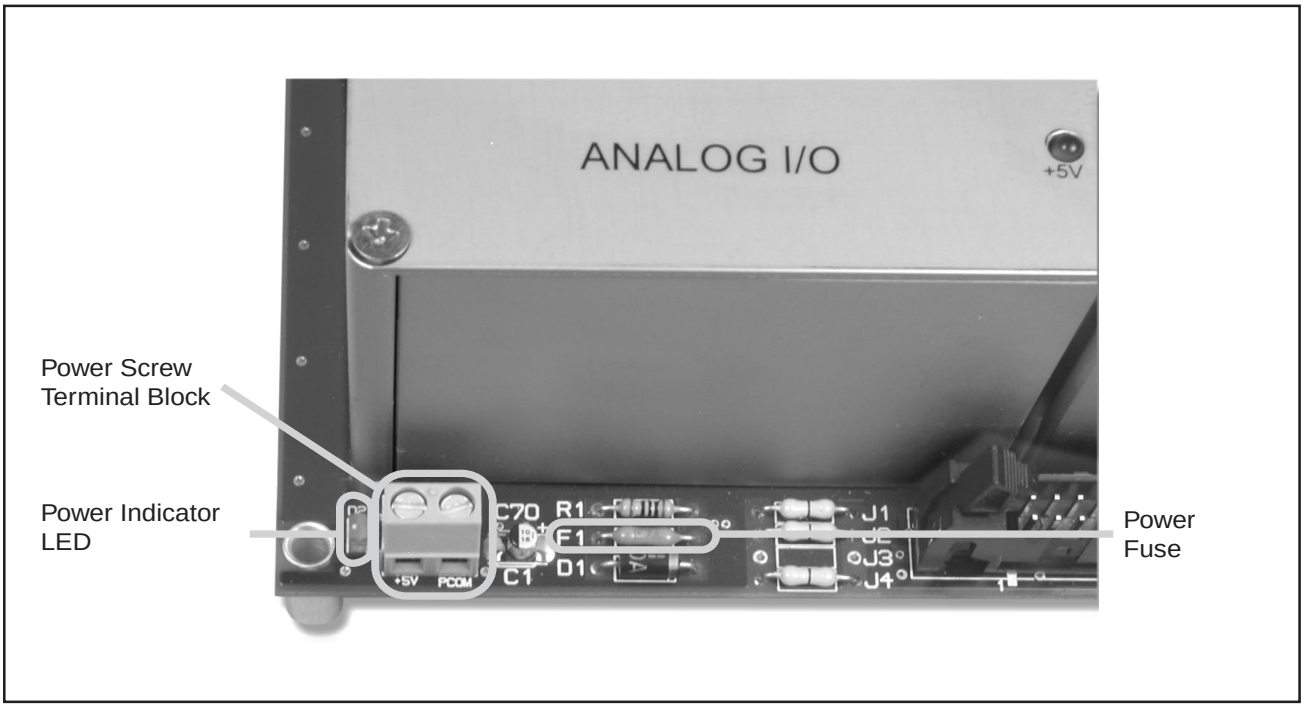

Figure 4.2.4-1

Fusing

The isoLynx Analog I/O Base Unit Backpanel power is fuse protected through F1 shown in Figure 4.2.4-1. This is a Littlefuse type 252007, 7 amp fuse. Zener diode D1 provides extra protection by clamping the input power voltage to +5.6V. If the input supply voltage connection is reversed, this zener diode will be forward biased and fuse F1 will be blown.

4.2.5 Other Considerations

Communication Interface Reset Jumper

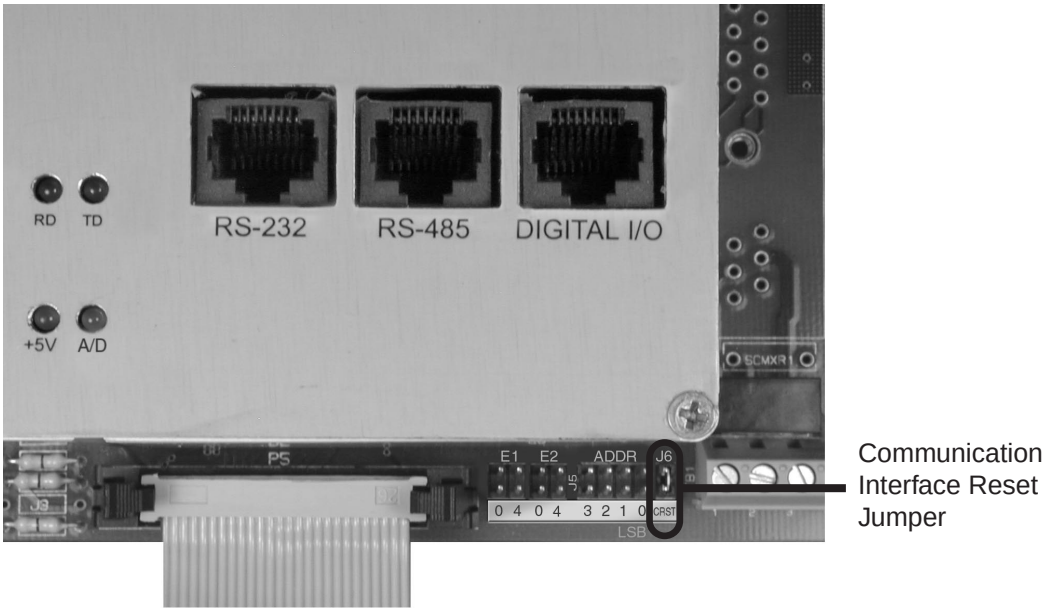

Figure 4.2.5-1

For situations in which the isoLynx to be installed has unknown communications parameters, a hardware reset jumper has been provided. This jumper is near the network address jumpers as shown in Figure 4.2.5-1. Opening the header pins momentarily with the mini-link shunt jumper provided, resets the isoLynx communications parameters to RS-232 interface at 9.6K bits per second (bps)(Baud) data rate. The shunt jumper must be re-installed over both pins and left there for the reset to complete and for continuous operation to begin. This function is one of the troubleshooting guidelines discussed in Appendix A – Troubleshooting.

The factory default setting is the jumper is set.

4.3 Functional Description

4.3.1 Industrial Communication Board

Ethernet

The Industrial Communication Board together with the Ethernet module serve as the interface to an Ethernet 10BaseT network. The Industrial Communication Board communicates internally with the Processor Board over a serial data link.

4.3.2 Processor Board

The Processor Board serves as the central controller for the isoLynx system. Its functions include data communications for receiving, interpreting, and executing commands, storing and manipulating data and configuration parameters; commanding configuration changes to the hardware; communicating with the Digital I/O Backpanels; and gathering and communicating data and status to the host computer.

4.3.3 I/O Signal Converter Board

The I/O Signal Converter Board serves as the central data conversion function for both input and output signals. It also has the ability to read a ground reference and a voltage reference for internal calibration purposes.

4.3.4 Analog I/O Base Unit Backpanel

The Analog I/O Base Unit Backpanel serves as the hardware “glue” for the isoLynx system. It is the carrier for the isoLynx function boards and as well as up to 12 SCM5B analog I/O modules. It is also the central connection point for expansion backpanels, their associated signals, and grounding configuration for the system.

The Analog I/O Base Unit Backpanel has two analog buses; one for analog input and one for analog output. This two-bus configuration takes advantage of the switch controlled outputs on the input modules and the track-and-hold inputs on the output modules. The backpanel address jumpers determine whether the backpanel will function in standalone or expansion mode. The addressing decoder circuitry allows a controller to select any channel in the address space. A temperature sensor is mounted on each channel to provide cold junction compensation for thermocouple input modules.

5.0 Analog I/O Expansion Backpanels Description

5.1 SCMPB02, 16-Position Analog I/O Backpanel

The SCMPB02 16-channel backpanel (Figure 5.1.1-1) can accept any of the SCM5B analog modules in any mixture. It can be mounted on the SCMXRK-002 19-inch metal rack. The SCMPB02 has two analog buses; one for analog input and one for analog output. This two-bus configuration takes advantage of the switch controlled outputs on the input modules and the track-and-hold inputs on the output modules. A temperature sensor is mounted on each channel to provide cold junction compensation for thermocouple input modules (See Figure 5.1.1-2 for schematic). Field connections are terminated with four screw terminals at each module site. Up to three SCMPB02 backpanels may be daisy-chained to the isoLynx Analog I/O Base Unit. Use SCMXCA004-XX cable for daisy chaining.

5.1.1 SCM5B Modules

For an extensive list of available modules, refer to Appendix B.3, SCM5B Selection Guide.

Installation

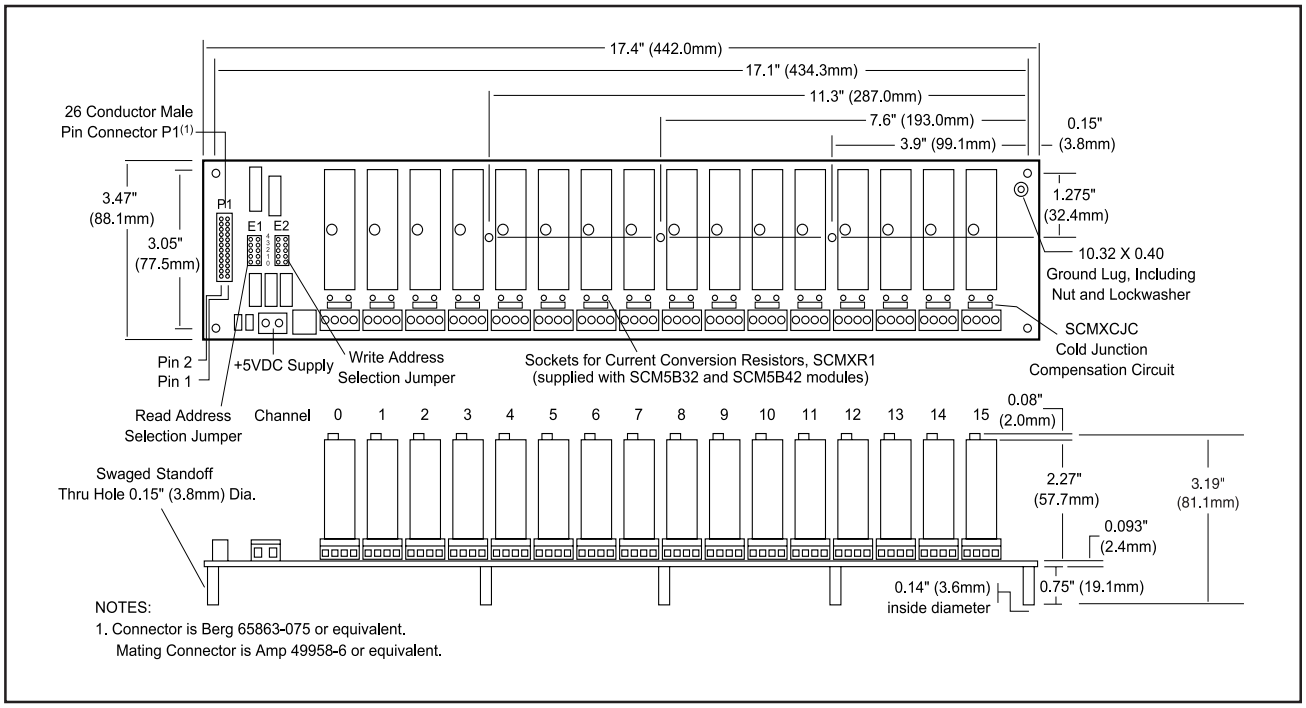

Figure 5.1.1-1

Each channel position on the backpanel has 14 sockets and a threaded insert. An SCM5B module plugs in only one way into the socket pattern. The module has a captive fastening screw which may be tightened into the threaded insert.

Wiring

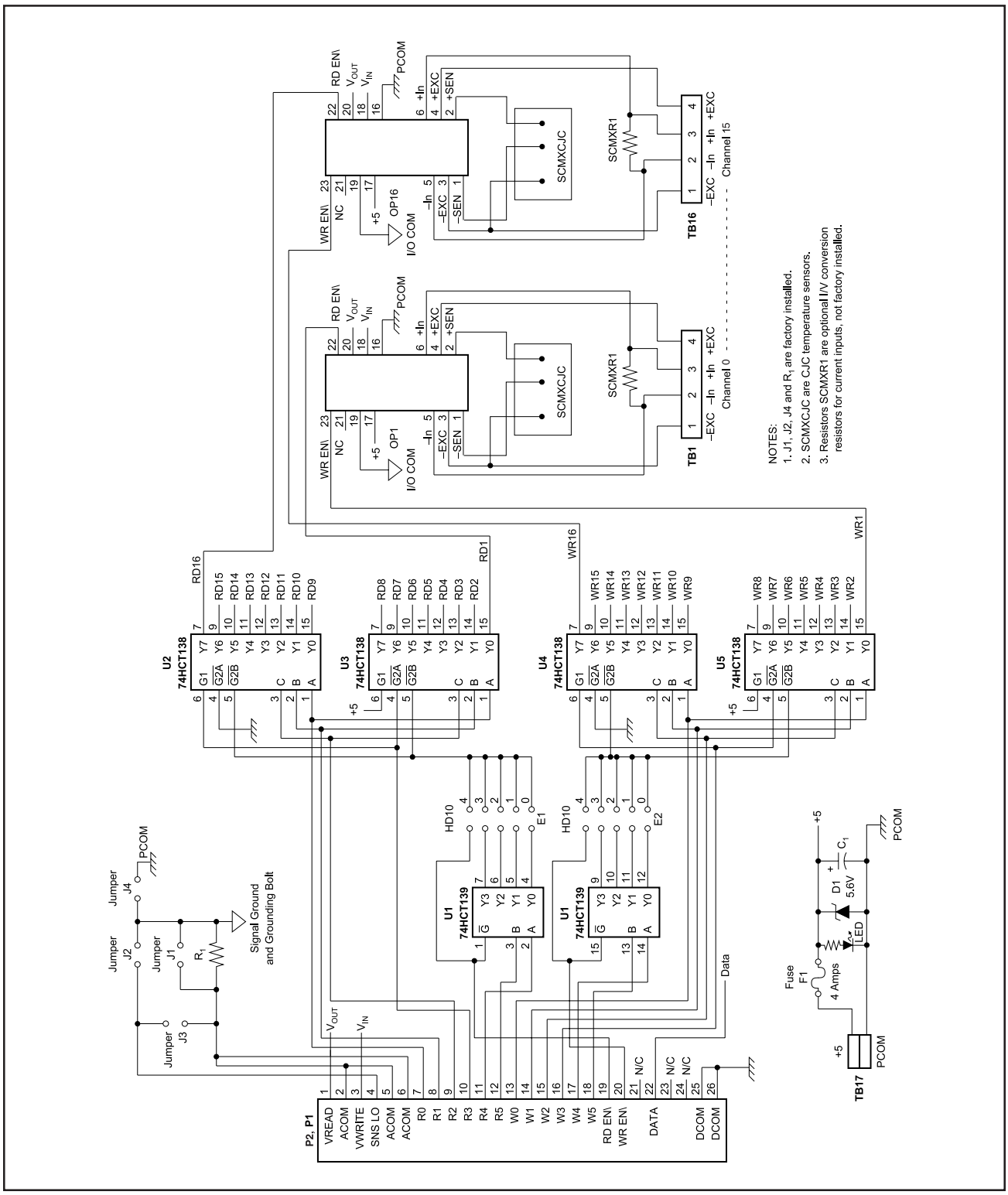

Figure 5.1.1-2

Field connections are made through the screw terminal blocks in front of the channel positions on the backpanel (TB1 – TB16). Figure 5.1.1-2 schematic shows the functions of the electrical connections.

5.1.2 Expansion Considerations

Address Selection

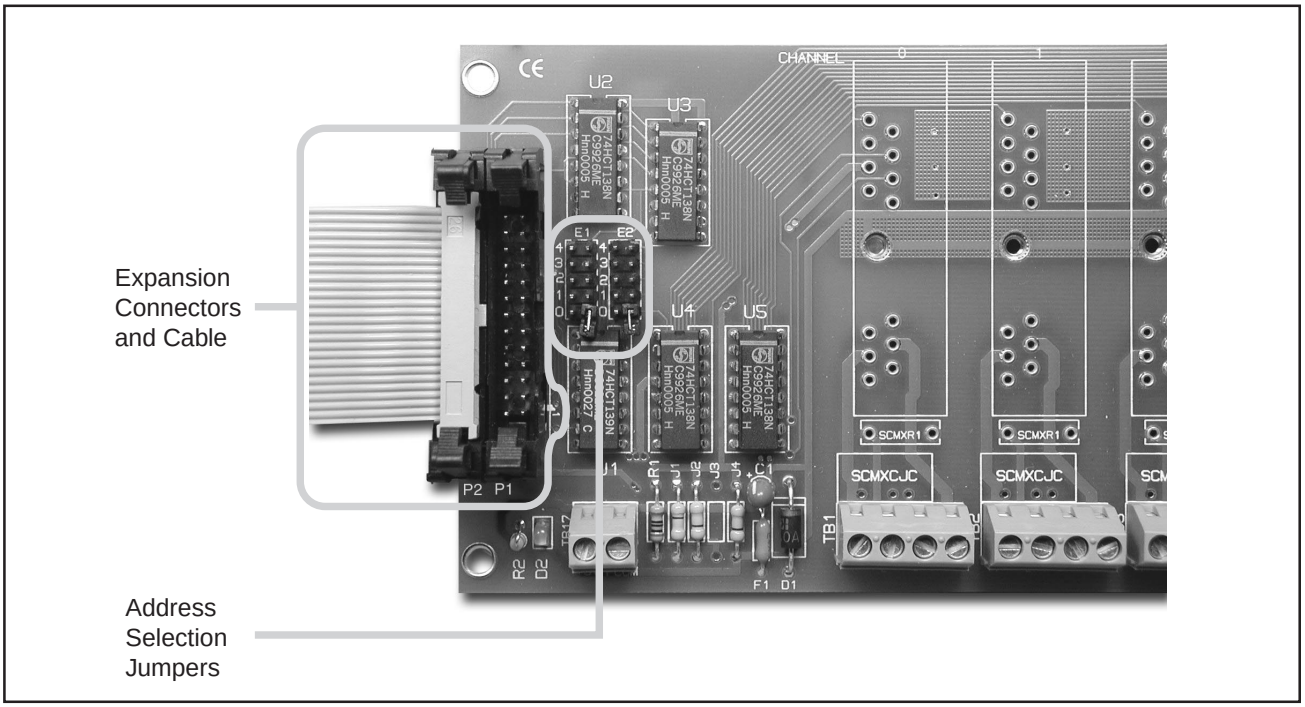

Figure 5.1.2-1

The SCMPB02 backpanel has address decoding circuitry to allow multiplexing any combination of up to 16 input or output modules. Capability is also provided in the address decode circuitry to expand the system to 60 channels (three SCMPB02 backpanels + one isoLynx Analog I/O Base Unit) of multiplexed input or output. Jumpers on HD10 header, E1 and E2 group, select which set of 16 addresses are assigned to a particular backpanel. The E1 group assigns a set of 16 addresses for input modules, and the E2 group assigns a set of 16 addresses for output modules. Channels 12-15 are not available in an isoLynx system.

The table below shows the correlation of jumper position to address range. The factory default settings are: E1, 4 through 1 are open and 0 is set; E2, 4 through 1 are open and 0 is set.

E1 Jumper Pos	**E2 Jumper Pos**	**Address Range/Mode**
4	4	0-15, STAND ALONE NOT USED WITH isoLynx
3	3	48-63, EXPANDED
2	2	32-47, EXPANDED
1	1	16-31, EXPANDED
0	0	0-15, EXPANDED NOT USED WITH isoLynx

To connect multiple SCMPB02 backpanels in this expanded configuration, use interconnect cable SCMXCA004-XX. Refer to sections 4.2.2 and 5.2.2 for details on isoLynx Analog I/O Base Unit Backpanel and SCMPB06 Backpanel expansion procedures.

Expansion Connectors (P1, P2)

The 26 pin connectors P1 and P2 provide the signal interface between the SCMPB02 backpanel and the isoLynx System. Two separate analog buses are provided; one for analog input signals and one for analog output signals. Two sets of six address lines and an enable pin allow input and output modules to be independently multiplexed onto their respective analog signal bus. R0 thru R5 and RDENAB are used for input modules, and W0 thru W5 and WRENAB are used for output modules.

5.1.3 Grounding Considerations

Backpanel Jumpers

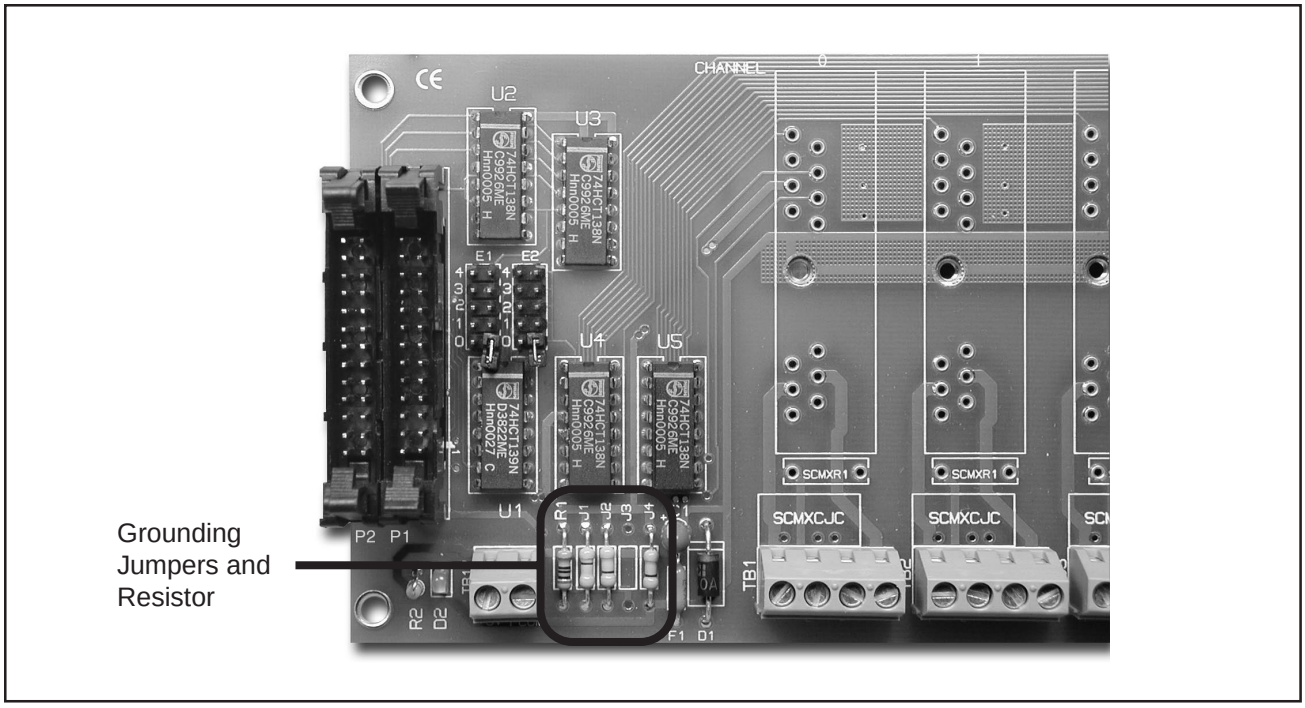

Figure 5.1.3-1

For proper operation of the output switch or track-and-hold circuit when using the SCMPB02/06 backpanels, a current path must exist between the host control logic power common and module I/O Common (module pin 19). This path can be established on the SCMPB02 via jumper J4. If this connection exists elsewhere in the system, jumper J4 should be removed since possible ground loops could exist. Other connections of power ground and signal ground usually occur at the A/D or D/A converter of the host measurement system. More information on grounding can be found in Appendix C.2 - AN303 SCM5B Expansion Backpanel Ground Connections.

If the connection of power common and SIG COM shield wires exist in the host measurement system, a resistive connection between SIG COM and the backpanel signal ground can be made via R1. R1 can be as large as 10K ohms; 100 ohms is a recommended value.

Grounding Stud

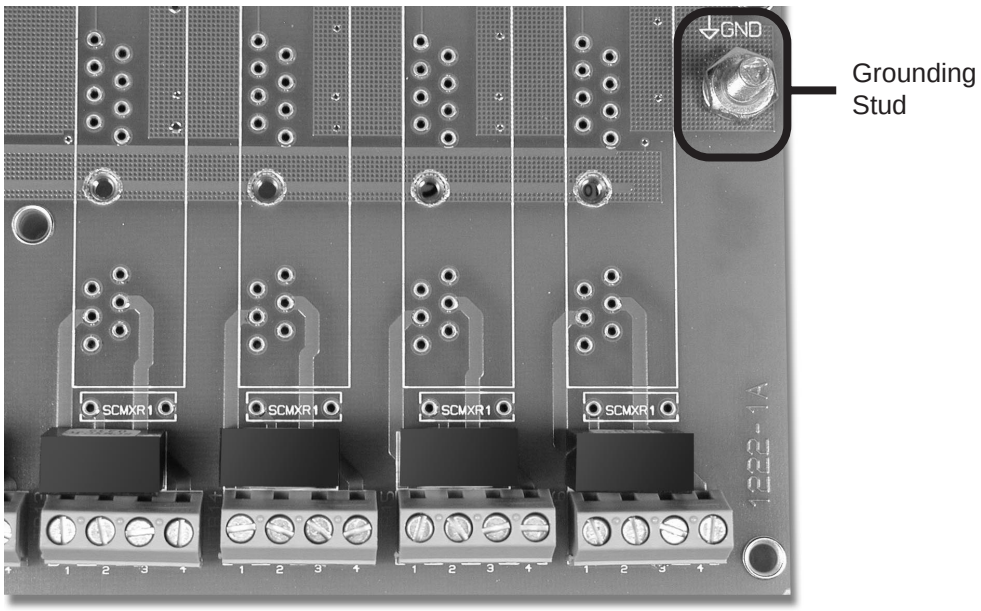

Figure 5.1.3-2

For full protection against large electrical disturbances on the field-side of the SCM5B modules, a #10-32 ground stud is provided on the backpanel. An electrical connection between this ground stud and system ground should be provided with a large gauge wire of the shortest possible length. When this connection is made, a possible ground loop could result through the SIG COM shield wires and backpanel signal ground. If the application involves only input modules and a differential input is used by the host measurement system, J1 should be removed. Remember that J1 is required if output modules are used or if the host system does not have differential inputs.

5.1.4 Power Considerations

Power Supply, Connector, and LED

The SCMPB02 backpanel requires external +5VDC ±5% power. The chassis mounted SCMXPRE-003 or SCMXPRT-003 power supplies have adequate capacity to power any combination of modules. The power connection is made through the two position screw terminal block as outlined in Figure 5.1.4-1. The LED outlined in Figure 5.1.4-1 lights when a proper power connection has been made.

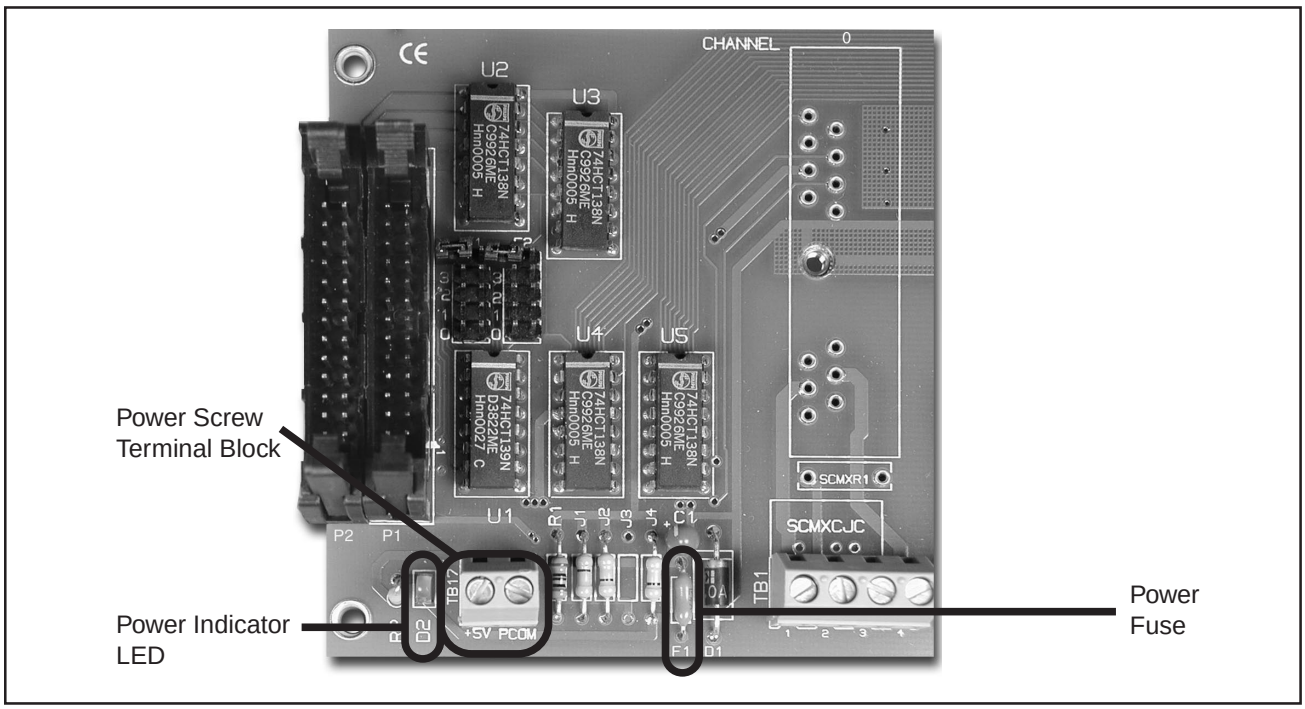

Figure 5.1.4-1

Fusing

The SCMPB02 backpanel power is fuse protected through F1 outlined in Figure 5.1.4-1. This is a Littlefuse type 252004, 4 amp fuse. Zener diode D1 provides extra protection by clamping the input power voltage to +5.6V. If the input supply voltage connection is reversed, this zener diode will be forward biased and fuse F1 will be blown.

5.1.5 Functional Description

The SCMPB02 has two analog buses; one for analog input and one for analog output. This two-bus configuration takes advantage of the switch controlled outputs on the input modules and the track-and-hold inputs on the output modules. The address jumpers determine where in the address space an individual backpanel will reside. The addressing decoding circuitry allows a controller to select any channel in the address space. A temperature sensor is mounted on each channel to provide cold junction compensation for thermocouple input modules.

5.2 SCMPB06, 8-Position Analog I/O Backpanel

The SCMPB06 backpanel (Figure 5.2.1-1) can accept up to eight SCM5B modules in any combination. It can be mounted on the SCMXRK-002 19-inch metal rack. The SCMPB06 has two analog buses; one for analog input and one for analog output. This two-bus configuration takes advantage of the switch controlled outputs on the input modules and the track-and-hold inputs on the output modules. A temperature sensor is mounted on each channel to provide cold junction compensation for thermocouple input modules (See Figure 5.2.1-2 for schematic). Field connections are terminated with four screw terminals at each module site. Up to seven SCMPB06 backpanels may be daisy-chained to the isoLynx Analog I/O Base Unit. Use SCMXCA004-XX cable for daisy chaining.

Jumpers on the SCMPB06 permit user selection of low (i.e. channels 0-7) or high (i.e. channels 8-15) addresses.

5.2.1 SCM5B Modules

For an extensive list of available modules, refer to Appendix B.3, SCM5B Selection Guide.

Installation

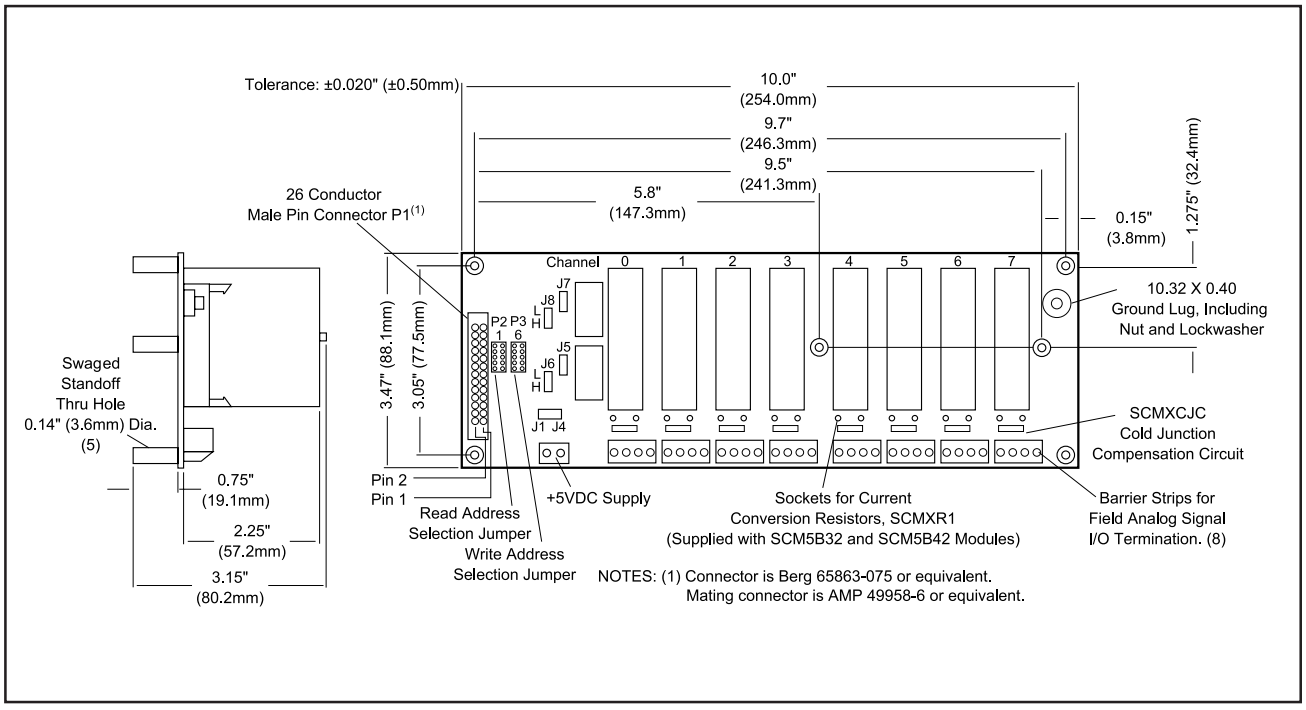

Figure 5.2.1-1

Each channel position on the backpanel has 14 sockets and a threaded insert. An SCM5B module plugs in only one way into the socket pattern. The module has a captive fastening screw which may be tightened into the threaded insert.

Wiring

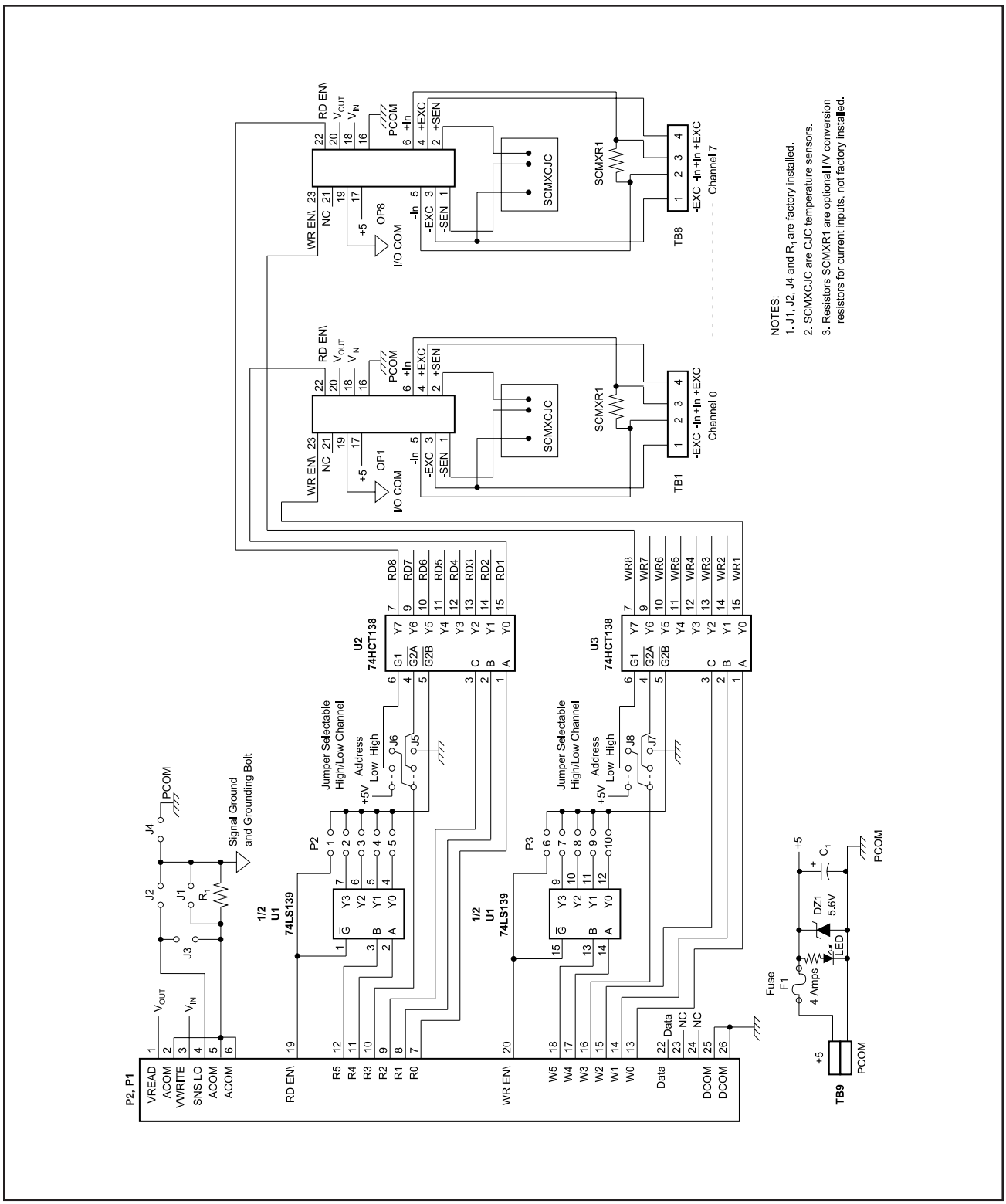

Figure 5.2.1-2

Field connections are made through the screw terminal blocks in front of the channel positions on the backpanel (TB1 – TB8). Figure 5.2.1-2 schematic shows the functions of the electrical connections.

5.2.2 Expansion Considerations

Address Selection

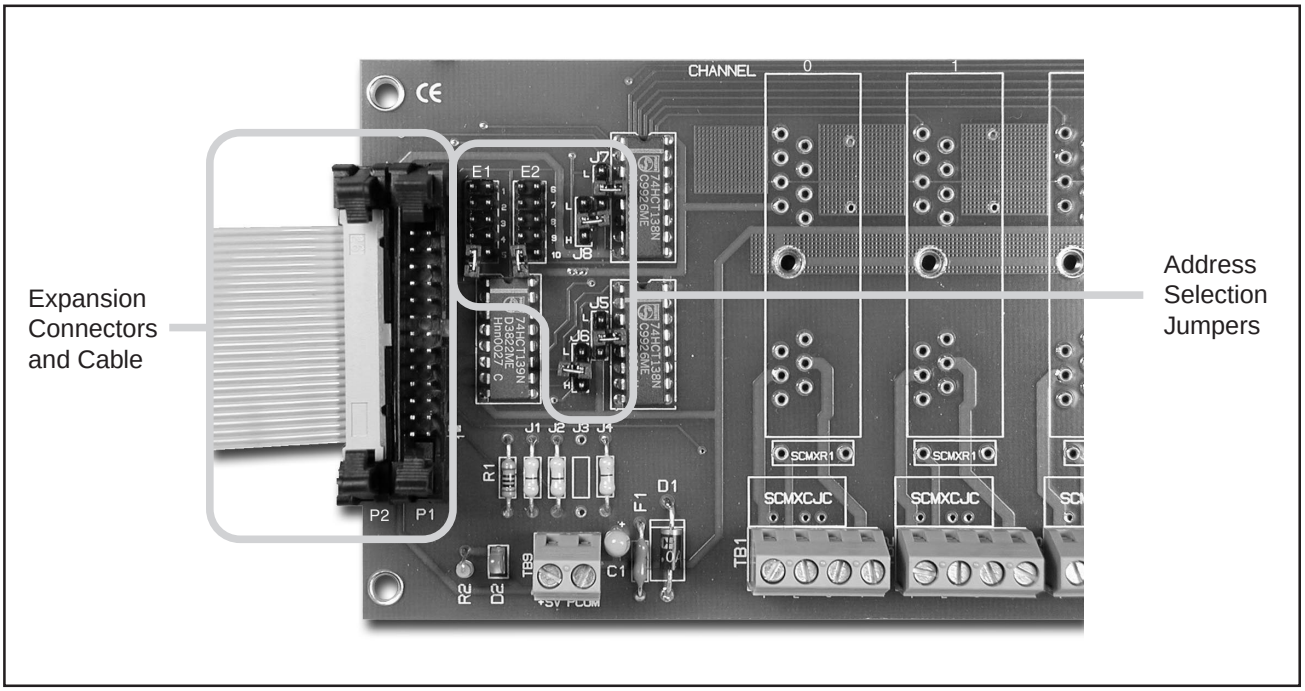

Figure 5.2.2-1

The SCMPB06 backpanel has address decoding circuitry to allow multiplexing any combination of up to 8 input or output modules. Capability is also provided in the address decode circuitry to expand the system to 60 channels (seven SCMPB06 backpanels + one isoLynx Analog I/O Base Unit) of multiplexed input or output. Jumpers select which set of 16 addresses are assigned to a particular backpanel. Channels 12-15 are not available in an isoLynx system.

The table below shows the correlation of jumper position to address range. The factory default settings are: E1, 4 through 1 are open and 0 is set; E2, 4 through 1 are open and 0 is set.

Read Address Jumper (E1)	**Write Address Jumper (E2)**	**Address Range/Mode**
1	6	0-15, STAND ALONE NOT USED WITH isoLynx
2	7	48-63, EXPANDED
3	8	32-47, EXPANDED
4	9	16-31, EXPANDED
5	10	0-15, EXPANDED NOT USED WITH isoLynx

Module read and write addresses may be selected as low (channels 0-7) or high (channels 8-15) using the four sets of 3 position jumpers labeled J5 through J8. Place a jumper over the two pins furthest from the field I/O termination blocks on all four sets to select a low address (factory configuration) or over the two pins closest to the field I/O termination blocks on all four sets to select a high address.

The factory default settings are: J5 through J8, HI are open and LO are set.

To connect multiple SCMPB06 backpanels in this expanded configuration, use interconnect cable SCMXCA004-XX. Refer to sections 4.2.2 and 5.1.2 for details on isoLynx Analog I/O Base Unit Backpanel and SCMPB02 Backpanel expansion procedures.

Expansion Connectors (P1, P2)

The 26 pin connectors P1 and P2 provide the signal interface between the SCMPB06 backpanel and the isoLynx System. Two separate analog buses are provided; one for analog input signals and one for analog output signals. Two sets of six address lines and an enable pin allow input and output modules to be independently multiplexed onto their respective analog signal bus. R0 thru R5 and RDENAB are used for input modules, and W0 thru W5 and WRENAB are used for output modules.

5.2.3 Grounding Considerations

Backpanel Jumpers

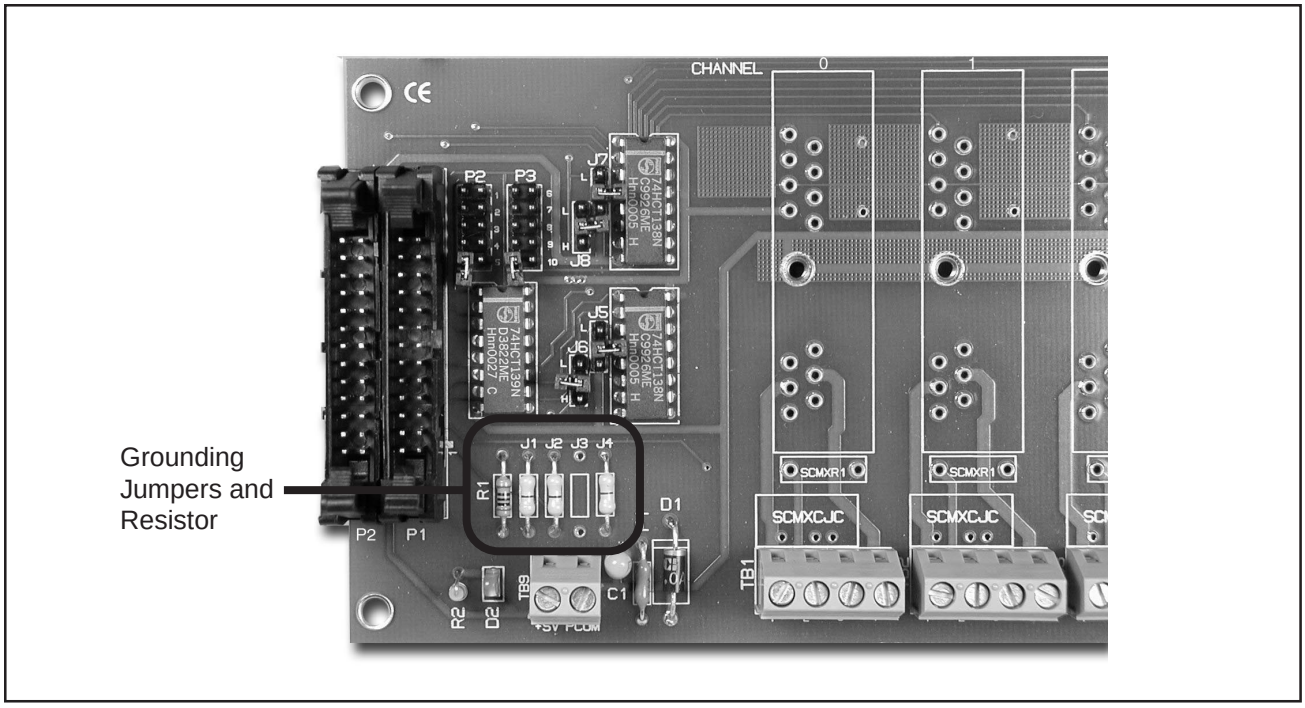

Figure 5.2.3-1

For proper operation of the output switch or track-and-hold circuit when using the SCMPB02/06 backpanels, a current path must exist between the host control logic power common and module I/O Common (module pin 19). This path can be established on the SCMPB06 via jumper J4. If this connection exists elsewhere in the system, jumper J4 should be removed since possible ground loops could exist. Other connections of power ground and signal ground usually occur at the A/D or D/A converter of the host measurement system. More information on grounding can be found in Appendix C.2 - AN303 SCM5B Expansion Backpanel Ground Connections.

If the connection of power common and SIG COM shield wires exist in the host measurement system, a resistive connection between SIG COM and the backpanel signal ground can be made via R1. R1 can be as large as 10K ohms; 100 ohms is a recommended value.

Grounding Stud

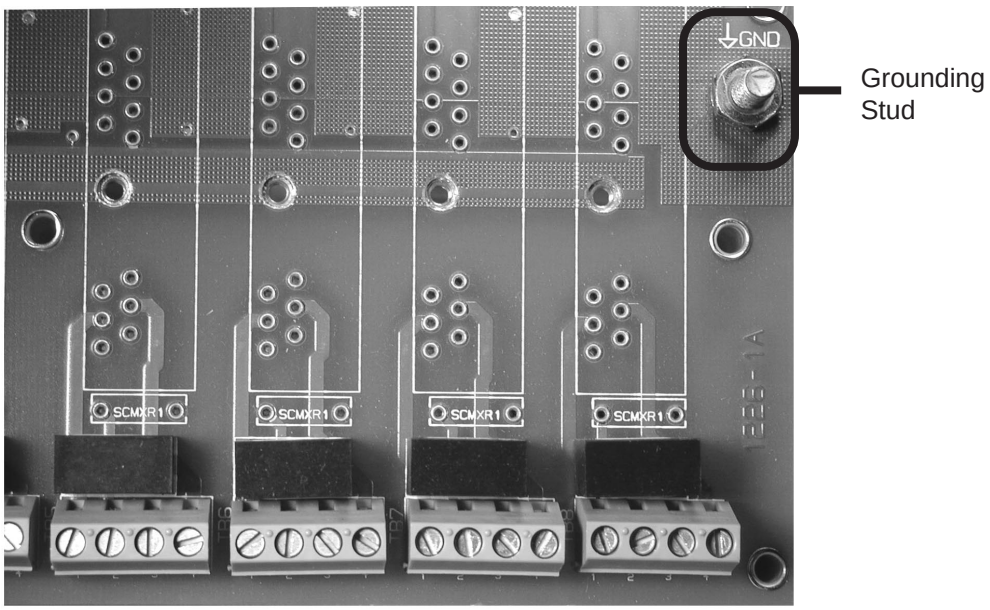

Figure 5.2.3-2

For full protection against large electrical disturbances on the field-side of the SCM5B modules, a #10-32 ground stud is provided on the backpanel. An electrical connection between this ground stud and system ground should be provided with a large gauge wire of the shortest possible length. When this connection is made, a possible ground loop could result through the SIG COM shield wires and backpanel signal ground. Remember that J1 is required.

5.2.4 Power Considerations

Power Supply, Connector, and LED

The SCMPB06 backpanel requires external +5VDC ±5% power. The chassis mounted SCMXPRE-003 or SCMXPRT-003 power supplies have adequate capacity to power any combination of modules. The power connection is made through the two position screw terminal block as outlined in Figure 5.2.4-1. The LED outlined in Figure 5.2.4-1 lights when a proper power connection has been made.

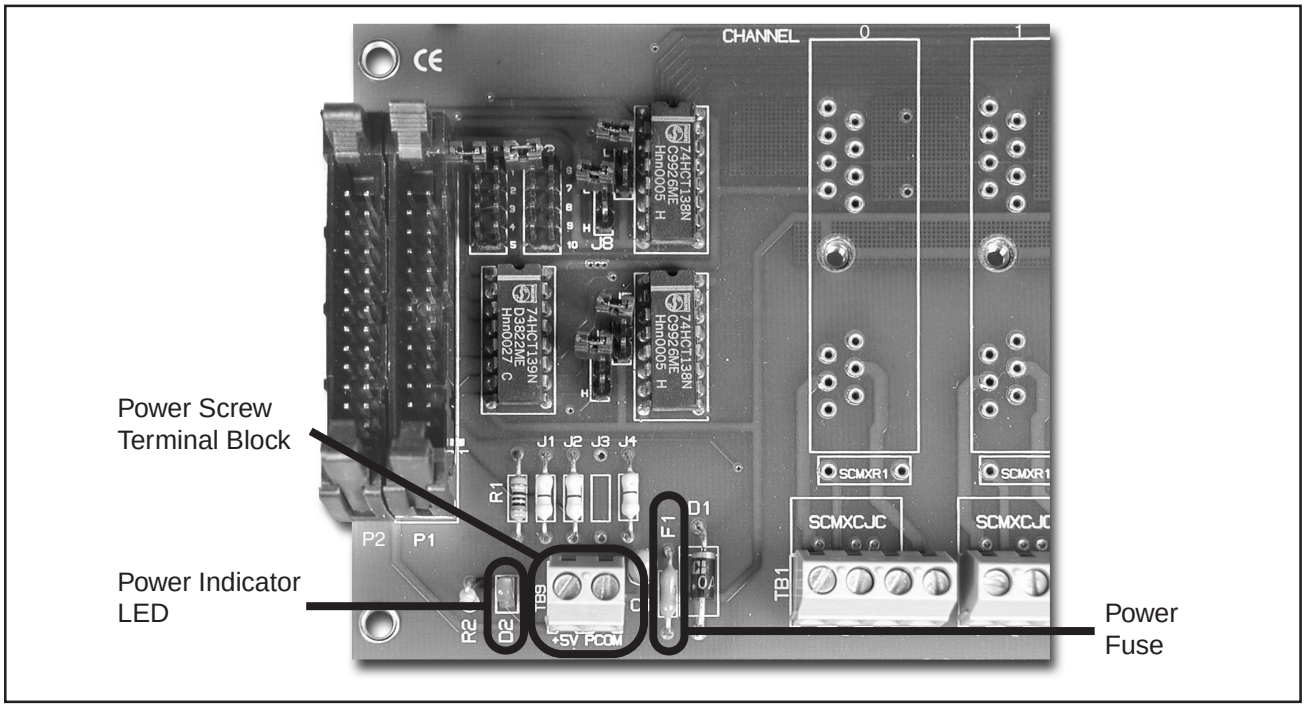

Figure 5.2.4-1

Fusing

The SCMPB06 backpanel power is fuse protected through F1 outlined in Figure 5.2.4-1. This is a Littlefuse type 252004, 4 amp fuse. Zener diode D1 provides extra protection by clamping the input power voltage to +5.6V. If the input supply voltage connection is reversed, this zener diode will be forward biased and fuse F1 will be blown.

5.2.5 Functional Description

The SCMPB06 has two analog buses; one for analog input and one for analog output. This two-bus configuration takes advantage of the switch controlled outputs on the input modules and the track-and-hold inputs on the output modules. The address jumpers determine where in the address space an individual backpanel will reside. The addressing decoder circuitry allows a controller to select any channel in the address space. Additionally, since each SCMPB06 can accommodate only 8 modules, module read and write addresses may be selected as low (channels 0-7) or high (channels 8-15). A temperature sensor is mounted on each channel to provide cold junction compensation for thermocouple input modules.

6.0 isoLynx™ Digital I/O Backpanel Description

6.1 SCMD Modules

For an extensive list of available modules, refer to Appendix B.5, SCMD Selection Guide.

Installation

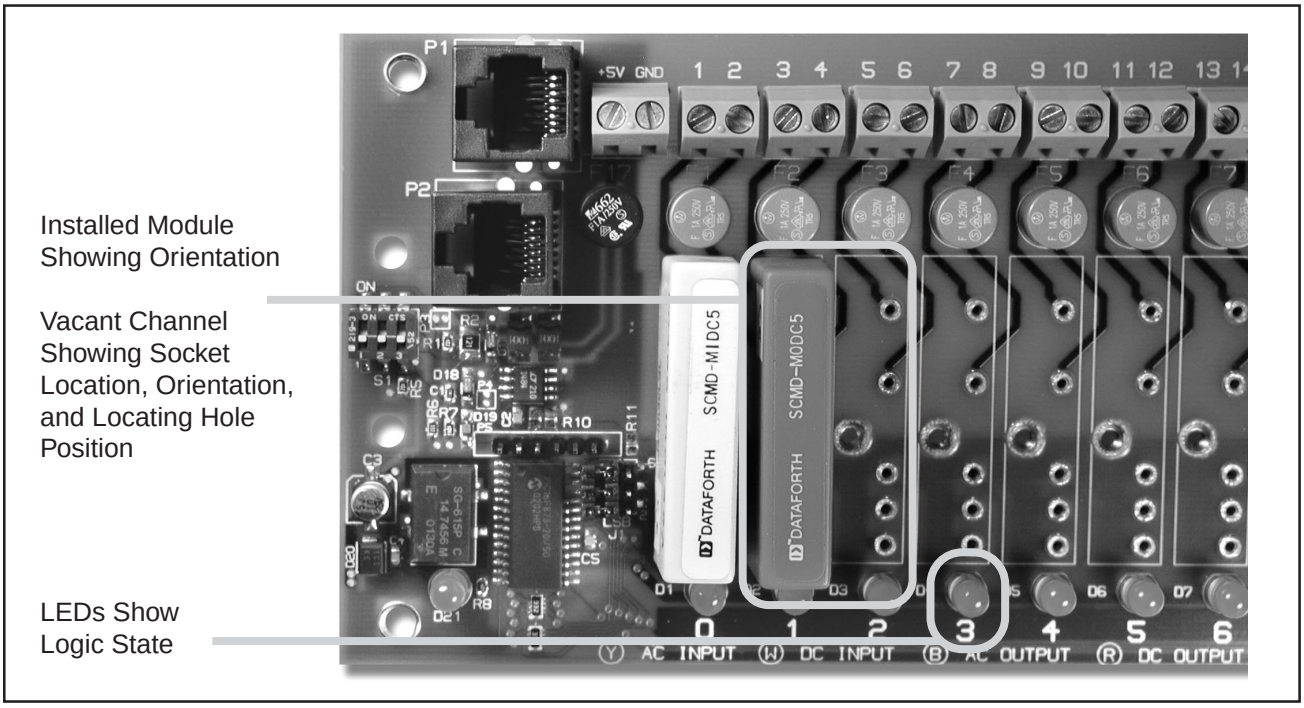
Installed Module Showing Orientation
Vacant Channel Showing Socket Location, Orientation, and Locating Hole Position
LEDs Show Logic State
P1
P2
+5V GND
1 2 3 4 5 6 7 8 9 10 11 12 13
SCMD-MIDC5
SCMD-MODC5
DATAFORTH
0 1 2 3 4 5 6
Ⓨ AC INPUT Ⓦ DC INPUT Ⓑ AC OUTPUT Ⓡ DC OUTPUT

Figure 6.1-1

Each channel position on the backpanel has 5 sockets and a threaded insert. An SCMD module plugs in only one way into the socket pattern. The module has a locating peg or screw which slides or threads into the threaded insert.

LEDs

Each channel has an LED in front of the channel position. The LED indicates the logic state of the channel input or output. When the LED is on, the input or output function is asserted. When the LED is off, the input or output function is disasserted.

Wiring

Field connections are made through the screw terminal blocks behind the channel positions on the backpanel (1 – 32). Figure 6.1-2 shows the polarity of the field connections.

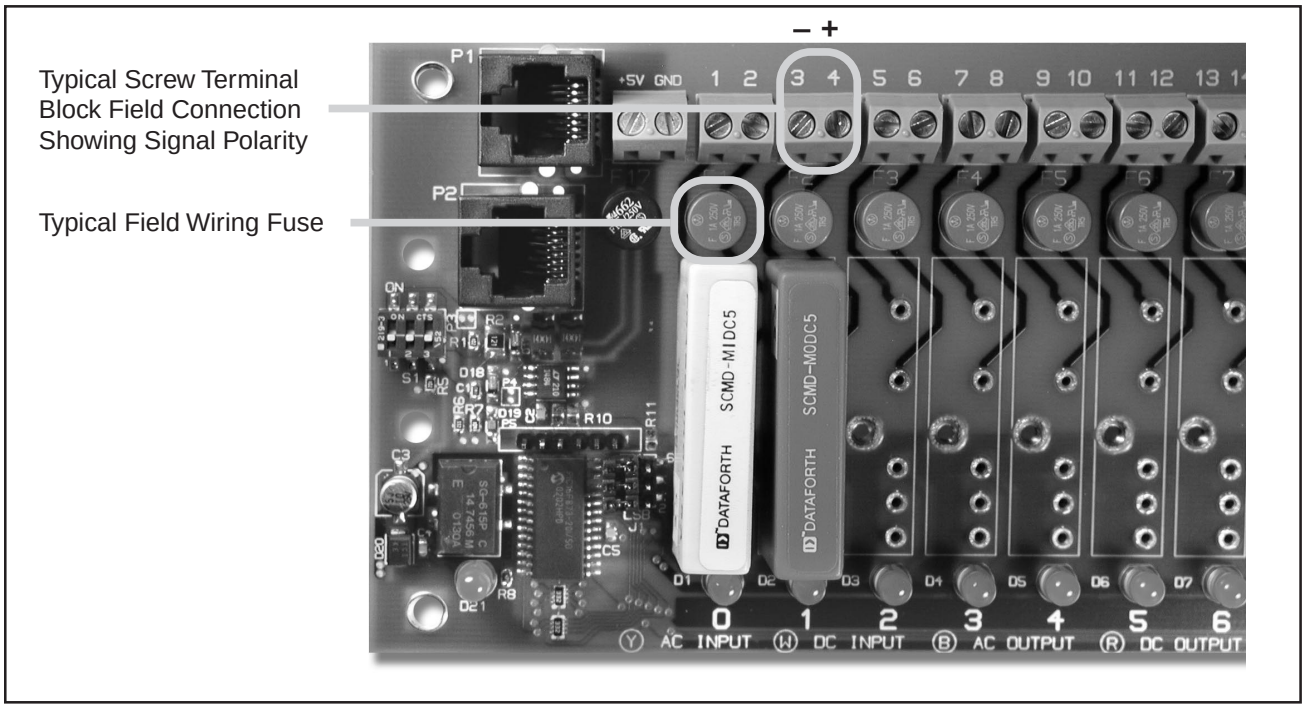
Typical Screw Terminal Block Field Connection Showing Signal Polarity
Typical Field Wiring Fuse
– +
P1
P2
+5V GND 1 2 3 4 5 6 7 8 9 10 11 12 13
SCMD-MIDC5
SCMD-MODC5
DATAFORTH
0 1 2 3 4 5 6
Ⓨ AC INPUT Ⓦ DC INPUT Ⓑ AC OUTPUT Ⓡ DC OUTPUT

Figure 6.1-2

Fusing

Each channel has a replaceable fuse between the module and the field wiring screw terminal blocks. A spare fuse is located between the terminal blocks for channel 7 (terminal 16) and 8 (terminal 17).

6.2 Expansion Considerations

Network Address Selection

The jumpers outlined in Figure 6.2-1 select the Digital I/O Backpanel's network address in a multidropped Digital I/O Expansion Network (for more on this, refer to Expansion Network Termination Network Switches below and Appendix D).

There is a three jumper group, J1, which allow for 8 addresses. The LSB (Least Significant Bit) of the address lines is the jumper designated as LSB on the board. A jumper over both pins of any jumper position corresponds to a 0 (zero) in the address and an open (a jumper over one pin) in any jumper position corresponds to a 1 (one) in the address. To obtain a particular address, just arrange jumpers in the binary weighted pattern of the hexadecimal value desired.

Factory default is all jumpers are set (network address 0).

Expansion Network Connectors (P1, P2)

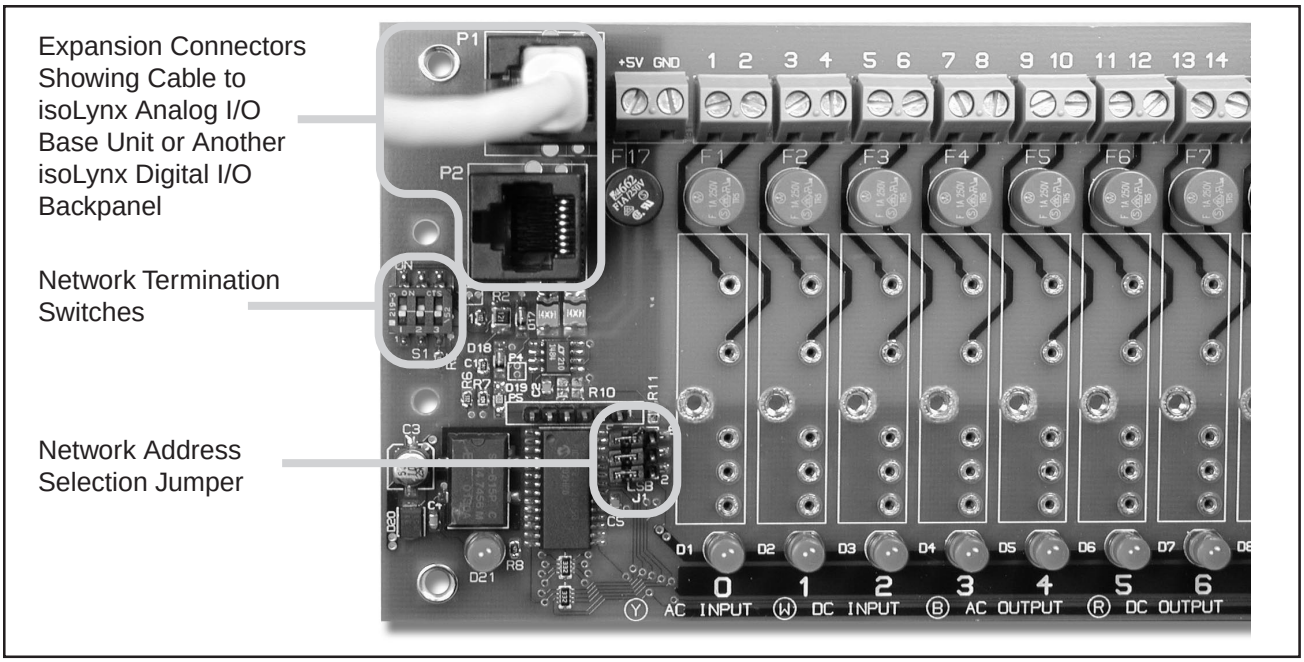
Expansion Connectors Showing Cable to isoLynx Analog I/O Base Unit or Another isoLynx Digital I/O Backpanel
Network Termination Switches
Network Address Selection Jumper
P1
P2
+5V GND
1 2 3 4 5 6 7 8 9 10 11 12 13 14
F17
F1 F2 F3 F4 F5 F6 F7
S1
R10
R11
D1 D2 D3 D4 D5 D6 D7
0 1 2 3 4 5 6
Y AC INPUT W DC INPUT B AC OUTPUT R DC OUTPUT

Figure 6.2-1

Expansion Network Termination Network Switches

In general for differential trunk line lengths over 100 ft (30.5 m), the two devices at the extreme ends of the trunk line should be terminated and all other devices in between should not. The Digital I/O Backpanel offers a built-in termination network for the 2-wire Digital I/O network accessed through DIP switches. The location of the Digital I/O termination DIP switches are identified in Figure 6.2-1.

DIP switch, S1, sections 1 through 3 are used for the 2-wire Digital I/O network. Section 1 switches in a pull-down resistor for the A line of the differential signal. Section 3 switches in a pull-up resistor for the B line of the differential signal. The pull-down pull-up network provides the idle line biasing for the differential input. Section 2 switches the line impedance terminating resistor across the differential signal. In most cases, the installation will require sections 1 through 3 all to be switched to ON (termination network in). Some cases may allow fewer or no terminating elements to be in the network. This can be determined by a little experimentation; use the combination of elements which give the most reliable data transfer. Then document the settings.

Factory default is all DIP switch sections ON (termination network in).

For proper termination of all RS-485 devices in a 2-wire multidrop isoLynx Digital I/O Expansion Network, reference the application note in Appendix D - AN302 isoLynx™ RS-485 and Digital I/O Expansion Network Configurations.

6.3 Power Considerations

Power Supply, Connector, and LED

The Digital I/O Backpanel requires external +5VDC ±5% power. The chassis mounted SCMXPRE-003 or SCMXPRT-003 power supplies have adequate capacity to power any combination of modules. The power connection is made through the two position screw terminal block as outlined in Figure 6.3-1. The LED outlined in Figure 6.3-1 lights when a proper power connection has been made.

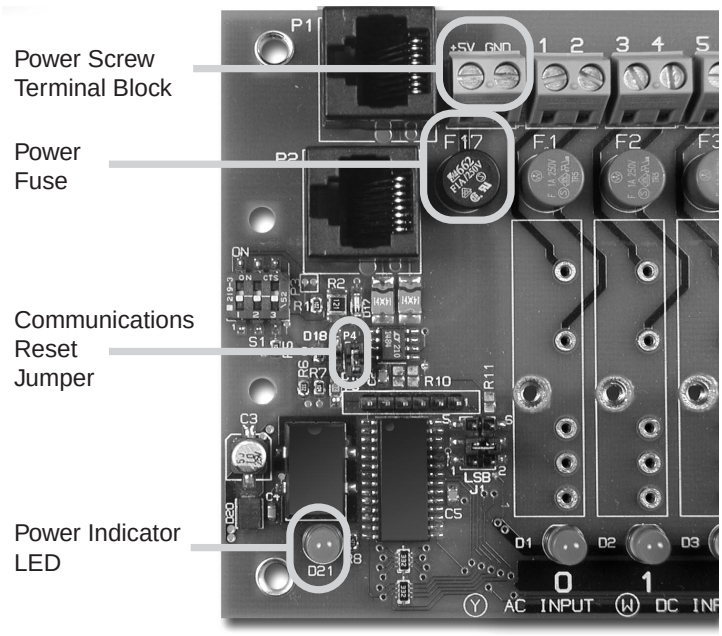

Figure 6.3-1

Fusing

The Digital I/O Backpanel power is fuse protected through F17 outlined in Figure 6.3-1. This is a 4 amp fuse. A Zener diode provides extra protection by clamping the input power voltage to +5.6V. If the input supply voltage connection is reversed, this zener diode will be forward biased and fuse F17 will be blown.

6.4 Other Considerations

Communication Interface Reset Jumper

For situations in which the Digital I/O Backpanel to be installed has an unknown data rate, a hardware reset jumper has been provided. This jumper is near the termination network DIP switch as outlined in Figure 6.3-1. Opening the header pins momentarily with the mini-link shunt jumper provided, resets the Digital I/O Backpanel data rate to 115.2K bits per second (bps)(Baud). The shunt jumper must be re-installed over both pins and left there for the reset to complete and for continuous operation to begin. This function is one of the troubleshooting guidelines discussed in Appendix A – Troubleshooting.

The factory default setting is the jumper is set.

6.5 Functional Description

The Digital I/O Backpanel serves as the carrier for the digital I/O microcontroller, the digital I/O expansion network communication circuits, and up to 16 SCMD digital I/O modules and their associated logic state indicator LEDs, field connection terminal blocks and protection fuses.

The digital I/O controller's functions include data communications for receiving, interpreting, and executing commands, storing and manipulating data and configuration parameters, commanding configuration changes to the hardware, and gathering and communicating data and status to the isoLynx Processor Board or the host computer.

7.0 Computer – isoLynx™ Communications

7.1 The Hardware – Software Connection

7.1.1 Using the Sample Application Software

With the isoLynx system pieces interconnected and configured and connected to a host computer, power up the isoLynx system and the host computer. Now refer to the *isoLynx™ Software User Manual* section 3.5 Sample Applications for a short tutorial on running the sample software. This tutorial demonstrates the basics of establishing a connection, configuring the isoLynx system parameters, and running data from input modules and to output modules.

7.1.2 Using isoLynx™ Command Protocol Commands Directly

With the isoLynx system pieces interconnected and configured and connected to a host computer, power up the isoLynx system and the host computer. Now refer to the *isoLynx™ Software User Manual* starting at chapter 2.0 isoLynx™ Command Reference for a descriptive overview. Refer to section 2.2 through section 2.10 for a detailed description of the commands, error response codes and messages and their meanings, and system level usage examples.

7.2 RS-232 Communications and Connections

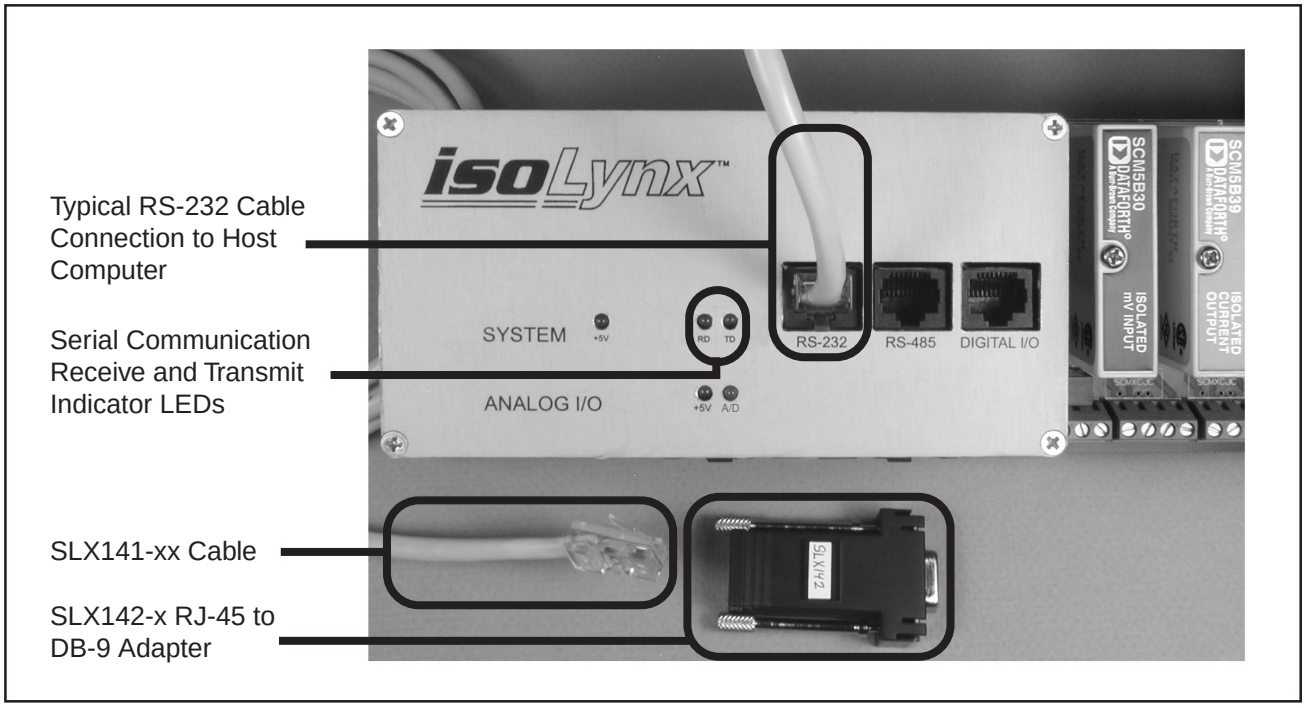

Figure 7.2-1

The following table shows the pinouts of the isoLynx RS-232 RJ-45 port and the SLX142-x RJ-45 to DB-9 adapter. The SLX142-x adapter provides a null modem connection which allows the connection of a Data Terminal Equipment (DTE), the isoLynx, to another DTE, the host computer.

SLX142-x			
isoLynx RS-232 EIA-561 Compatible		Host Computer Port RS-232 EIA-574 Compatible	
RJ-45 Position	Signal Name	DB-9(DCE) Position	Signal Name
4	Sig Gnd	5	Sig Gnd
5	RD	3	TD
6	TD	2	RD

7.3 RS-485 Communications and Connections

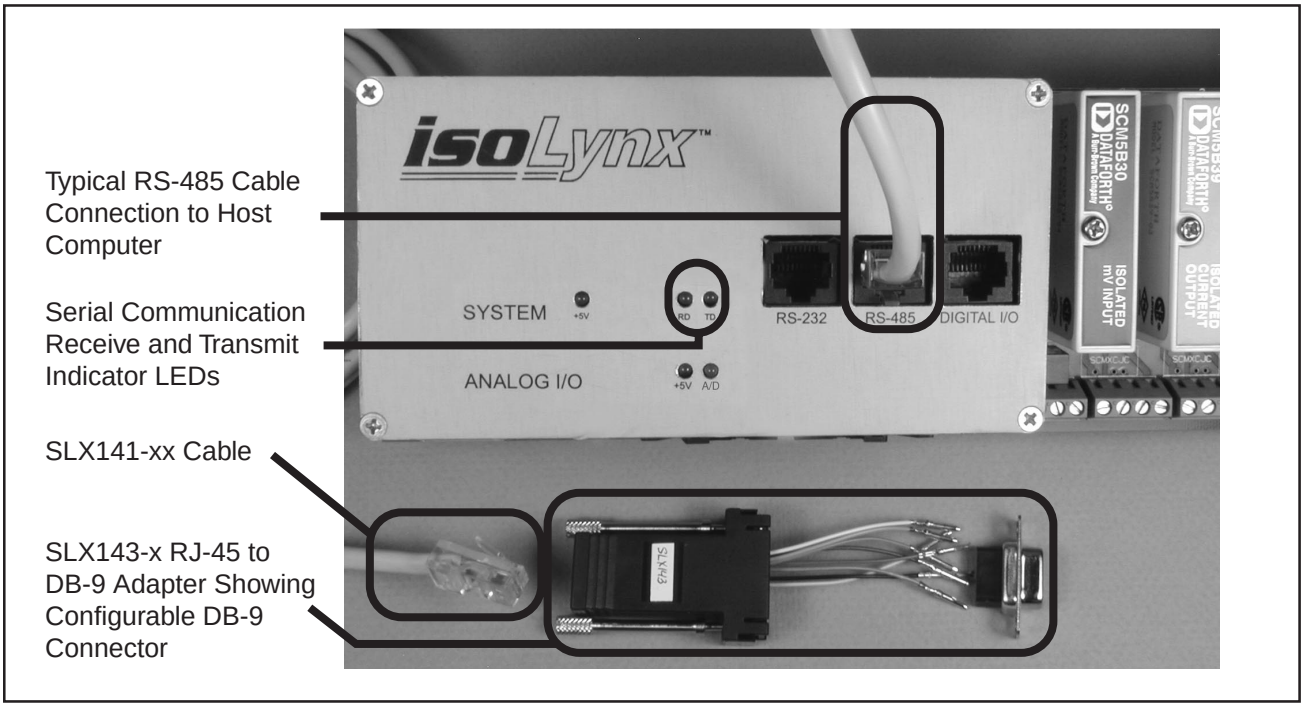

Figure 7.3-1

The following table shows the pinouts of the isoLynx RS-485 RJ-45 port and the SLX143-x uncommitted RJ-45 to DB-9 adapter. The SLX143-x allows adaptation to the DB-9 pinout of any RS-485 port card. The individual contacts may be inserted with fine point tweezers and a small straight blade screwdriver or with a DSUB contact insertion/extraction tool available at most electronic/computer parts stores. Unused contacts should be insulated and stored in the adapter backshell.

isoLynx RS-485		SLX143-x	
RJ-45 Position	Signal Name	RJ-45 Wire Color	DB-9 Position Uncommitted
1	Sig Gnd	Blue	?
2	Sig Gnd	Orange	?
3	RD1A’	Black	?
4	RD/TD1B	Red	?
5	RD/TD1A	Green	?
6	RD1B’	Yellow	?
7	Sig Gnd	Brown	?
8	Sig Gnd	White	?

7.4 Ethernet Communications and Connections

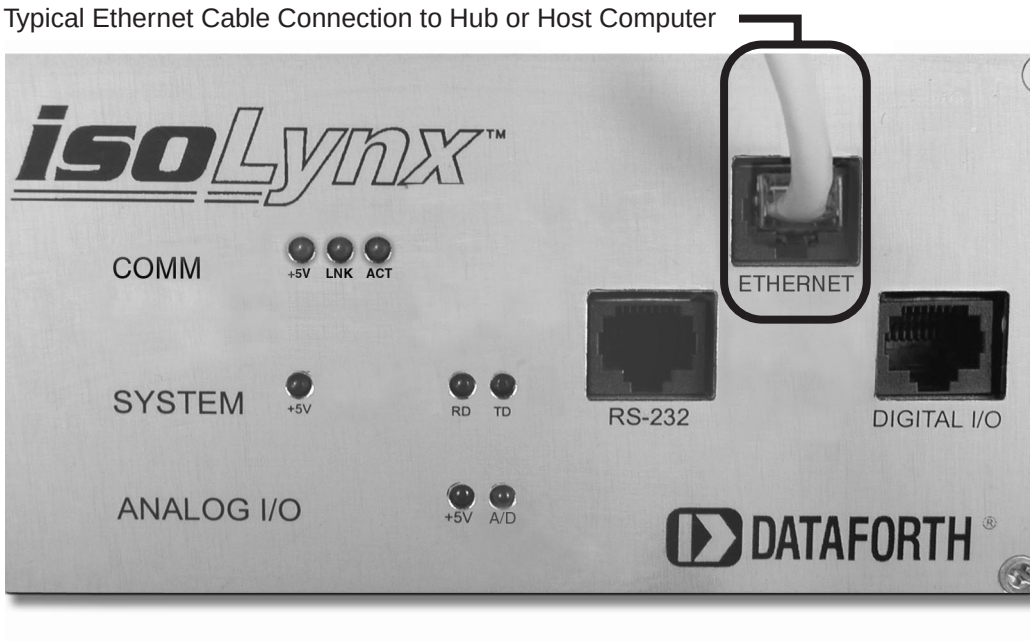

Figure 7.4-1

The following table shows the pinouts of the isoLynx Ethernet RJ-45 port.

isoLynx Ethernet	
RJ-45 Position	Signal Name
1	Receive+
2	Receive-
3	Transmit+
6	Transmit-

Appendix A - Troubleshooting Guidelines

A.1 isoLynx™ Controller A/D LED Blink Patterns

The following LED blink patterns identify various correct and/or erroneous operational modes of the isoLynx bootup, self-test, and continuous modes. Whenever you encounter any of the erroneous mode blink patterns, remember to check the hardware setup and connections.

Equal ON/OFF	isoLynx booted normally, fully operational, awaiting commands.
Long Blink	Long ON, Short OFF. Communication timeout. isoLynx has not received a command from the host within the 3 second Watchdog timeout period.
Short Blink	Short ON, Long OFF. I/O Signal Converter Board alert.
2 Short Blinks	Short ON, Short OFF, Short ON, Long OFF. Processor Board alert.
Full OFF	No power, LED circuit failed OFF, isoLynx firmware hung when LED was OFF.
Full ON	LED circuit failed ON, isoLynx firmware hung when LED was ON.

A.2 If the isoLynx™ Does Not Communicate or Sends Garbled Data From Any Interface

If the isoLynx Analog I/O Base Unit or Digital I/O Backpanel boots correctly but has unknown communication parameters, the communication parameters can be reset to a known state.

- Open the header pins momentarily with the mini-link shunt jumper provided on header J6. The shunt jumper must be re-installed over both pins and left there for the reset to complete and for continuous operation to begin.

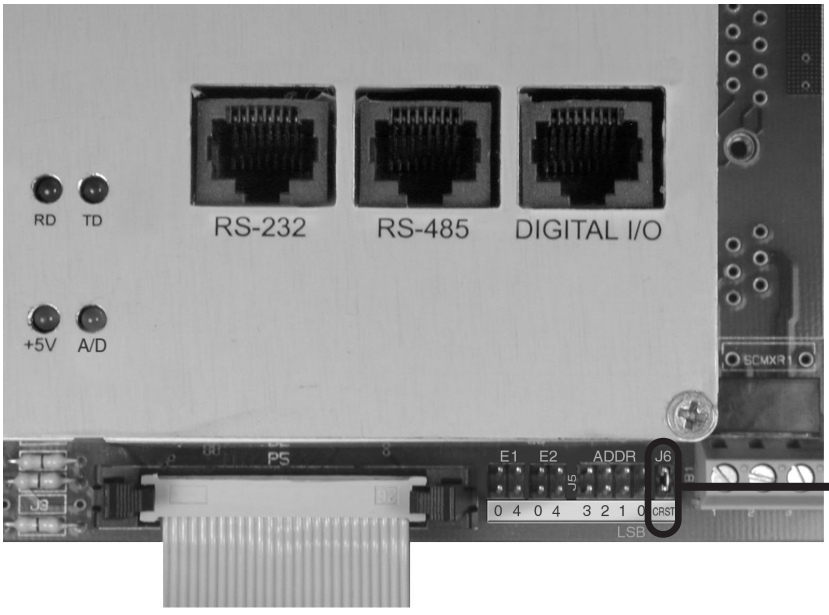

Figure A.2-1

- The isoLynx will be triggered to start a boot-up sequence. Once it has finished booting up, you may communicate with it through the RS-232 port at 9.6K bits per second (bps) (Baud).

A.3 If in RS-485 the isoLynx™ Does Not Communicate or Sends Garbled Data

For point-to-point RS-485, refer to section 4.1.3.2 and Appendix D of this manual, *isoLynx™ Hardware User Manual*, check that the termination network switches are set as described.

For multidropped RS-485, refer to section 4.1.3.2 and Appendix D of this manual, *isoLynx™ Hardware User Manual*, check that the termination network switches are set as described.

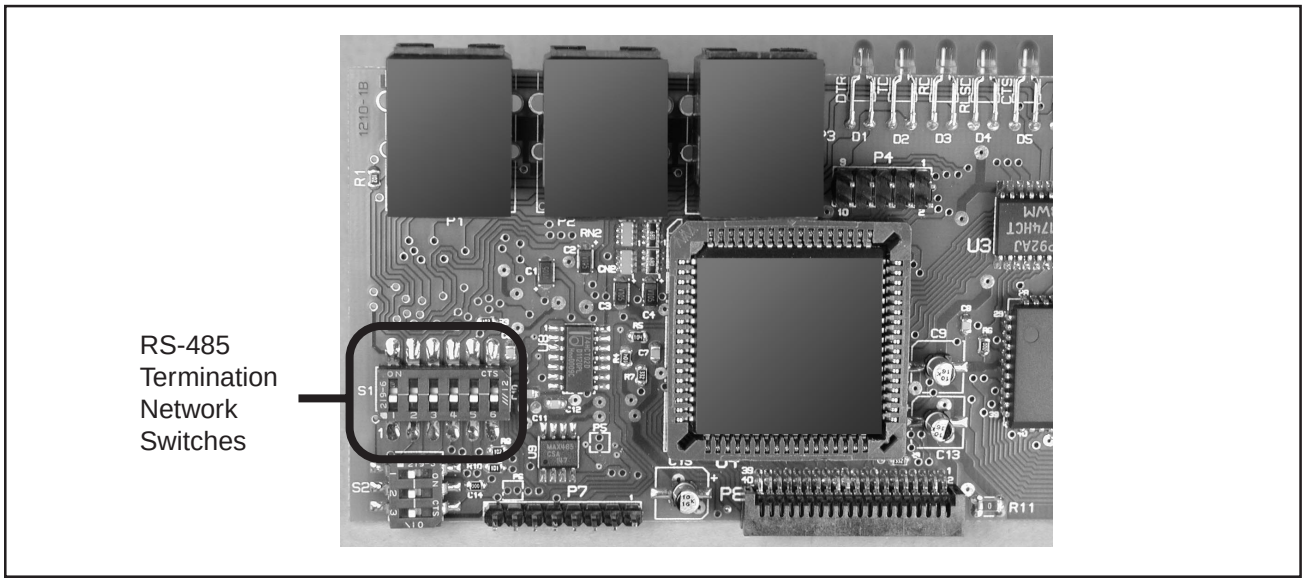

Figure A.3-1

An alternative possibility is for multiple isoLynx systems multidropped on an RS-485 network that two or more of them are set to the same network address. To check this, refer to section 4.2.2 under Network Address Selection which describes where the address selection jumpers are on the isoLynx Analog I/O Base Unit Backpanel and how to set them for no address duplication.

A.4 If the isoLynx™ Is Communicating But Error Codes Persist

In most cases, this is due to wrong fields in commands, configuration errors, or attempting to read or write a vacant channel. Refer to the *isoLynx™ Software User Manual* chapter 2.0 isoLynx™ Command Reference to find where the error is.

In some cases, this is due to hardware errors such as, EEPROM write errors, A/D time-out errors, or communcations link time-out errors. If your system is not adversely affected, you may choose to continue or to call your regional Dataforth representative or Dataforth directly at 800 444 7644.

A.5 If the Digital I/O Backpanel Does Not Communicate or Sends Garbled Data

For situations in which the Digital I/O Backpanel to be installed has an unknown data rate, a hardware reset jumper has been provided. This jumper is near the termination network DIP switch as outlined in Figure 6.3-1. Opening the header pins momentarily with the mini-link shunt jumper provided, resets the Digital I/O Backpanel data rate to 115.2K bits per second (bps)(Baud). The shunt jumper must be re-installed over both pins and left there for the reset to complete and for continuous operation to begin.

The other possibility for garbled data are the expansion network termination network settings. To determine and verify this, refer to section 6.2 Expansion Considerations, subheading, Expansion Network Termination Network Switches and Appendix D of this manual, *isoLynx™ Hardware User Manual*, check that the termination network switches are set as described.

Appendix B - Specifications, Factory Defaults, and Selection Guides

B.1 isoLynx™ Analog I/O Base Unit

Digital System:	
Microcontroller	High Performance RISC
Status LEDs	2 on I/O Signal Converter Board: +5V, A/D 3 on Processor Board: +5V, TD, RD
Communication Interface:	
Serial I/O (RS-232, RS-485)	RJ-45 modular phone jack each
Termination Networks Factory Default	S1, sections 1-3 ON, sections 4-6 OFF
Digital I/O	RJ-45 modular phone jack
Termination Networks Factory Default	S2, sections 1-3 ON
Communications (Ethernet)	RJ-45 modular phone jack
Analog I/O:	
Channels	Mix and match I/O types on a per channel basis Maximum 60 channels differential I/O of SCM5B modules
Field Connector	high density screw clamp, 14 AWG max
System Connector	26-pin, male header connector
Jumpers Factory Default	
E1, E2	0 set, 4 open
ADDR	all set = address 0
CRST	set
A/D Converter	16 bit, 100KHz, +/-10V input, 16 bit resolution 14 bit accuracy minimum. Resolution vs. input range: 16/+/-10V, 15/+/-5V, 14/0-5V
D/A Converter	16 bit, 100KHz analog output
Isolation	1500 Vrms ch-to-ch or ch-to-internal bus
Input Protection	240VAC continuous, 5KV peak per ANSI/IEEE C37.90.1-1989
Throughput	8 msec for 16 chs analog input (~2000 ch/sec) with 115.2kbps RS-232/485 16 msec for 16 chs analog output (~1000 ch/sec) with 115.2kbps RS-232/485
Operating Temperature	-40°C to +85°C
Storage Temperature	-40°C to +85°C
Relative Humidity	95%, non-condensing
Certifications	CSA and FM Approvals Pending, CE Compliant

B.2 Analog I/O Expansion Backpanels

SCMPB02

Operating Temperature:	-40°C to +85°C 95% relative humidity, non-condensing
Interface Connector: Field System	 high density screw clamp, 14 AWG max 26-pin, male header connector
Address Jumpers Factory Default E1, E2 Address Input Logic Levels: Max Logic “0” Min Logic “1”	 0 set, 1-4 open 0.8V 2.0V
I_I Input Current, “0” or “1”	0.1µA max at 25°C 1.0µA max -25°C to +85°C
RD EN\ or WR EN\ Signal Delay from Connector P1, P2 to Channels 12-27 Expanded (address 12-60)	 100ns at 25°C 126ns at -25°C to +85°C

SCMPB06

Operating Temperature:	-40°C to +85°C 95% relative humidity, non-condensing
Interface Connector: Field System	 high density screw clamp, 14 AWG max 26-pin, male header connector
Address Jumpers Factory Default E1, E2 J5-J8 Address Input Logic Levels: Max Logic “0” Min Logic “1”	 0 set, 1-4 open HI open, LO set 0.8V 2.0V
I_I Input Current, “0” or “1”	0.1µA max at 25°C 1.0µA max -25°C to +85°C
RD EN\ or WR EN\ Signal Delay from Connector P1, P2 to Channels 0-7 Standalone (address 0-7) Expanded (address 8-60)	 51ns at 25°C 64ns at -25°C to +85°C 100ns at 25°C 126ns at -25°C to +85°C

B.3 SCM5B Selection Guide

ANALOG VOLTAGE INPUT MODULES, NARROW BANDWIDTH (4HzBW)

MODEL	INPUT RANGE	OUTPUT RANGE†	
SCM5B30-01	±10mV	±5V	
SCM5B30-02	±50mV	±5V	
SCM5B30-03	±100mV	±5V	
SCM5B30-04	±10mV	0 to +5V	
SCM5B30-05	±50mV	0 to +5V	
SCM5B30-06	±100mV	0 to +5V	
SCM5B30-07	±1V	±5V	High Input Z
SCM5B31-01	±1V	±5V	
SCM5B31-02	±5V	±5V	
SCM5B31-03	±10V	±5V	
SCM5B31-04	±1V	0 to +5V	
SCM5B31-05	±5V	0 to +5V	
SCM5B31-06	±10V	0 to +5V	
SCM5B31-07	±20V	±5V	
SCM5B31-08	±20V	0 to +5V	
SCM5B31-09	±40V	±5V	
SCM5B31-10	±40V	0 to +5V	

ANALOG CURRENT INPUT MODULES, 4Hz AND 1kHz BANDWIDTH

MODEL	INPUT RANGE	OUTPUT RANGE†	BW
SCM5B32-01	4 to 20mA	0 to +5V	4Hz
SCM5B32-02	0 to 20mA	0 to +5V	4Hz
SCM5B392-11	4 to 20mA	0 to +5V	1kHz
SCM5B392-12	4 to 20mA	±5V	1kHz
SCM5B392-13	4 to 20mA	0 to +10V	1kHz
SCM5B392-14	4 to 20mA	±10V	1kHz

ISOLATED TRUE RMS INPUT MODULES

MODEL	INPUT (rms)	OUTPUT (dc)
SCM5B33-01	0-100mV	0-5V
SCM5B33-02	0-1V	0-5V
SCM5B33-03	0-10V	0-5V
SCM5B33-04	0-150V	0-5V
SCM5B33-05	0-300V	0-5V
SCM5B33-06	0-1A	0-5V
SCM5B33-07	0-5A	0-5V
SCM5B33-01B	0-100mV	0-1mA
SCM5B33-02B	0-1V	0-1mA
SCM5B33-03B	0-10V	0-1mA
SCM5B33-04B	0-150V	0-1mA
SCM5B33-05B	0-300V	0-1mA
SCM5B33-06B	0-1A	0-1mA
SCM5B33-07B	0-5A	0-1mA
SCM5B33-01C	0-100mV	4-20mA
SCM5B33-02C	0-1V	4-20mA
SCM5B33-03C	0-10V	4-20mA
SCM5B33-04C	0-150V	4-20mA
SCM5B33-05C	0-300V	4-20mA
SCM5B33-06C	0-1A	4-20mA
SCM5B33-07C	0-5A	4-20mA
SCM5B33-01D	0-100mV	0-10V
SCM5B33-02D	0-1V	0-10V

ISOLATED TRUE RMS INPUT MODULES Cont.

SCM5B33-03D	0-10V	0-10V
SCM5B33-04D	0-150V	0-10V
SCM5B33-05D	0-300V	0-10V
SCM5B33-06D	0-1A	0-10V
SCM5B33-07D	0-5A	0-10V
SCM5B33-01E	0-100mV	0-20mA
SCM5B33-02E	0-1V	0-20mA
SCM5B33-03E	0-10V	0-20mA
SCM5B33-04E	0-150V	0-20mA
SCM5B33-05E	0-300V	0-20mA
SCM5B33-06E	0-1A	0-20mA
SCM5B33-07E	0-5A	0-20mA

LINEARIZED 2- OR 3-WIRE RTD INPUT MODULES (0 to +5V OUTPUT†, 4Hz BW)

MODEL	TYPE**	INPUT RANGE
SCM5B34-01	100Ω Pt	–100°C to +100°C (–148°F to +212°F)
SCM5B34-02	100Ω Pt	0°C to +100°C (+32°F to +212°F)
SCM5B34-03	100Ω Pt	0°C to +200°C (+32°F to +392°F)
SCM5B34-04	100Ω Pt	0°C to +600°C (+32°F to +1112°F)
SCM5B34-05	100Ω Pt	–100°C to +200°C (–148°F to +392°F)
SCM5B34C-01	10Ω Cu at 0°C	0°C to +120°C (+32°F to +248°F)
SCM5B34C-02	10Ω Cu at 25°C	0°C to +120°C (+32°F to +248°F)
SCM5B34C-03	10Ω Cu at 0°	0°C to +160°C (+32°F to +320°F)
SCM5B34N-01	120Ω Ni	0°C to +300°C (+32°F to +572°F)

LINEARIZED 4-WIRE RTD INPUT MODULES (0 to +5V OUTPUT†, 4Hz BW)

MODEL	TYPE**	INPUT RANGE
SCM5B35-01	100Ω Pt	–100°C to +100°C (–148°F to +212°F)
SCM5B35-02	100Ω Pt	0°C to +100°C (+32°F to +212°F)
SCM5B35-03	100Ω Pt	0°C to +200°C (+32°F to +392°F)
SCM5B35-04	100Ω Pt	0°C to +600°C (+32°F to +1112°F)
SCM5B35-05	100Ω Pt	–100°C to +200°C (–148°F to +392°F)
SCM5B35C-01	10Ω Cu at 0°C	0°C to +120°C (+32°F to +248°F)
SCM5B35C-02	10Ω Cu at 25°C	0°C to +120°C (+32°F to +248°F)
SCM5B35C-03	10Ω Cu at 0°C	0°C to +160°C (+32°F to +320°F)
SCM5B35N-01	120Ω Ni	0°C to +300°C (+32°F to +572°F)

POTENTIOMETER INPUT MODULES (4Hz BW)

MODEL	INPUT RANGE	OUTPUT RANGE†
SCM5B36-01	0 to 100Ω	0 to +5V
SCM5B36-02	0 to 500Ω	0 to +5V
SCM5B36-03	0 to 1kΩ	0 to +5V
SCM5B36-04	0 to 10kΩ	0 to +5V

THERMOCOUPLE INPUT MODULES (0 to +5V OUTPUT†, 4Hz BW)

MODEL	TYPE‡	INPUT RANGE
SCM5B37J	J	–100°C to +760°C (–148°F to +1400°F)
SCM5B37K	K	–100°C to +1350°C (–148°F to +2462°F)
SCM5B37T	T	–100°C to +400°C (–148°F to +752°F)
SCM5B37E	E	0°C to +900°C (+32°F to +1652°F)
SCM5B37R	R	0°C to +1750°C (+32°F to +3182°F)
SCM5B37S	S	0°C to +1750°C (+32°F to +3182°F)
SCM5B37B	B	0°C to +1800°C (+32°F to +3272°F)
SCM5B37C	C	+350°C to +1300°C (+662°F to +2372°F)
SCM5B37N	N	-100°C to +1300°C (-148°F to +2372°F)

STRAIN GAGE INPUT MODULES (±5V OUTPUT†, 4Hz or 10kHz BW)

MODEL		INPUT	EXCITATION
10KHz	4Hz		
SCM5B38-01	-31	±10mV Full Bridge Input, (3mV/V) 100 to 10kΩ	3.333V
SCM5B38-02	-32	±30mV Full Bridge Input, (3mV/V) 300 to 10kΩ	10.000V
SCM5B38-03	-33	±10mV Half Bridge Input, (3mV/V) 100 to 10kΩ	3.333V
SCM5B38-04	-34	±30mV Half Bridge Input, (3mV/V) 300 to 10kΩ	10.000V
SCM5B38-05	-35	±20mV Full Bridge Input, (2mV/V) 300 to 10kΩ	10.000V
SCM5B38-06	-36	±33.3mV Full Bridge Input, (10mV/V) 100 to 10kΩ	3.333V
SCM5B38-07	-37	±100mV Full Bridge Input, (10mV/V) 300 to 10kΩ	10.000V

ANALOG CURRENT OUTPUT MODULES, 400Hz AND 1kHz BANDWIDTH

MODEL	INPUT RANGE	OUTPUT RANGE	BW
SCM5B39-01	0 to +5V	4 to 20mA	400Hz
SCM5B39-02	±5V	4 to 20mA	400Hz
SCM5B39-03	0 to +5V	0 to 20mA	400Hz
SCM5B39-04	±5V	0 to 20mA	400Hz
SCM5B39-05	0 to 20mA	0 to 20mA	400Hz
SCM5B39-07	±10V	±20mA	275Hz
SCM5B392-01	0 to +5V	4 to 20mA	1kHz
SCM5B392-02	±5V	4 to 20mA	1kHz
SCM5B392-03	0 to +10V	4 to 20mA	1kHz
SCM5B392-04	±10V	4 to 20mA	1kHz

MATCHED PAIR SERVO/MOTOR CONTROLLER DRIVERS (1KHz BW)

MODEL	INPUT RANGE	INTERFACE	OUTPUT RANGE
SCM5B392-0111	0 to +5V	4 to 20mA	0 to +5V
SCM5B392-0212	±5V	4 to 20mA	±5V
SCM5B392-0313	0 to +10V	4 to 20mA	0 to +10V
SCM5B392-0414	±10V	4 to 20mA	±10V

ANALOG VOLTAGE INPUT MODULES, WIDE BANDWIDTH (10kHz BW)

MODEL	INPUT RANGE	OUTPUT RANGE†	
SCM5B40-01	±10mV	±5V	
SCM5B40-02	±50mV	±5V	
SCM5B40-03	±100mV	±5V	
SCM5B40-04	±10mV	0 to +5V	
SCM5B40-05	±50mV	0 to +5V	
SCM5B40-06	±100mV	0 to +5V	
SCM5B40-07	±1V	±5V	High Input Z
SCM5B41-01	±1V	±5V	
SCM5B41-02	±5V	±5V	
SCM5B41-03	±10V	±5V	
SCM5B41-04	±1V	0 to +5V	
SCM5B41-05	±5V	0 to +5V	
SCM5B41-06	±10V	0 to +5V	
SCM5B41-07	±20V	±5V	
SCM5B41-08	±20V	0 to +5V	
SCM5B41-09	±40V	±5V	
SCM5B41-10	±40V	0 to +5V	

2-WIRE TRANSMITTER INTERFACE MODULES (100Hz BW)

MODEL	INPUT RANGE	OUTPUT RANGE
SCM5B42-01	4 to 20mA	+1 to +5V
SCM5B42-02	4 to 20mA	+2 to +10V

GENERAL PURPOSE INPUT MODULES, DC EXCITATION

MODEL	MAXIMUM INPUT	OUTPUT†
SCM5B43-01	±1V	±5V
SCM5B43-02	±2V	±5V
SCM5B43-03	±3V	±5V
SCM5B43-04	±4V	±5V
SCM5B43-05	±5V	±5V
SCM5B43-06	±6V	±5V
SCM5B43-07	±7V	±5V
SCM5B43-08	±8V	±5V
SCM5B43-09	±9V	±5V
SCM5B43-10	±10V	±5V

FREQUENCY INPUT MODULES

MODEL		INPUT RANGE	OUTPUT RANGE†
±20mV HYST.	±400mV HYST.		
SCM5B45-01	SCM5B45-21	0 to 500Hz	0 to +5V
SCM5B45-02	SCM5B45-22	0 to 1kHz	0 to +5V
SCM5B45-03	SCM5B45-23	0 to 3kHz	0 to +5V
SCM5B45-04	SCM5B45-24	0 to 5kHz	0 to +5V
SCM5B45-05	SCM5B45-25	0 to 10kHz	0 to +5V
SCM5B45-06	SCM5B45-26	0 to 25kHz	0 to +5V
SCM5B45-07	SCM5B45-27	0 to 50kHz	0 to +5V
SCM5B45-08	SCM5B45-28	0 to 100kHz	0 to +5V

LINEARIZED THERMOCOUPLE INPUT MODULES (0 to +5V OUTPUT†, 4Hz BW)

MODEL	TYPE‡	INPUT RANGE
SCM5B47J-01	J	0°C to +760°C (+32°F to +1400°F)
SCM5B47J-02	J	–100°C to +300°C (–148°F to +572°F)
SCM5B47J-03	J	0°C to +500°C (+32°F to +932°F)
SCM5B47K-04	K	0°C to +1000°C (+32°F to +1832°F)
SCM5B47K-05	K	0°C to +500°C (+32°F to +932°F)
SCM5B47T-06	T	–100°C to +400°C (–148°F to +752°F)
SCM5B47T-07	T	0°C to +200°C (+32°F to +392°F)
SCM5B47E-08	E	0°C to +1000°C (+32°F to +1832°F)
SCM5B47R-09	R	+500°C to +1750°C (+932°F to +3182°F)
SCM5B47S-10	S	+500°C to +1750°C (+932°F to +3182°F)
SCM5B47B-11	B	+500°C to +1800°C (+932°F to +3272°F)
SCM5B47J-12	J	-100°C to +760°C (-148°F to +1400°F)
SCM5B47K-13	K	-100°C to +1350°C (-148°F to +2462°F)
SCM5B47K-14	K	0°C to +1200°C (+32°F to +2192°F)
SCM5B47N-15	N	-100°C to +1300°C (-148°F to +2372°F)

VOLTAGE OUTPUT MODULES, 50mA DRIVE CAPACITY (400 Hz BW)

MODEL	INPUT RANGE	OUTPUT RANGE
SCM5B49-01	0 to +5V	±5V
SCM5B49-02	±5V	±5V
SCM5B49-03	±5V	0 to +5V
SCM5B49-04	0 to +10V	±10V
SCM5B49-05	±10V	±10V
SCM5B49-06	±10V	0 to +10V
SCM5B49-07	±5V	±10V

ACCESSORIES

MODEL	DESCRIPTION
SCMPB02	Multiplexed, 16 channel backpanel.
SCMPB02-1	Multiplexed, 16 channel backpanel, no CJC.
SCMPB02-2	SCMPB02 with DIN rail mounting option.
SCMPB02-3	SCMPB02-1 with DIN rail mounting option.
SCMPB06	Multiplexed, 8 channel backpanel.
SCMPB06-1	Multiplexed, 8 channel backpanel, no CJC.
SCMPB06-2	SCMPB06 with DIN rail mounting option.
SCMPB06-3	SCMPB06-1 with DIN rail mounting option.
SCMXEV	Single channel SCM5B evaluation board.
SCMXCA004-xx	System interface cable for both analog backpanels.
SCMXRK-002	19 inch metal rack for mounting analog backpanels.
SCMXIF	Ribbon cable to screw terminal interface board.
SCMXIF-DIN	Universal Interface Board
SCMXCJC	Encapsulated cold junction compensation circuit.
SCM5BPT	Pass Thru
SCMXJP-003	Package of 10 jumpers.
SCMXFS-003	Package of 10, 4A fuses.
SCMXR1	Precision 20Ω resistor for SCM5B32 and SCM5B42.
SCM5B-PROTO	Breadboard Kit
SCMXRAIL1-XX	DIN EN50022-35x7.5 (slotted steel), length -XX in meters.
SCMXRAIL2-XX	DIN EN50035-G32 (slotted steel), length -XX in meters.
SCMXRAIL3-XX	DIN EN50022-35x15 (slotted steel), length -XX in meters.
SCMXPRT-001	Power supply, 1A, 5VDC, 120VAC U.S.
SCMXPRE-001	Power supply, 1A, 5VDC, 220VAC European.
SCMXPRT-003	Power supply, 3A, 5VDC, 120VAC U.S.
SCMXPRE-003	Power supply, 3A, 5VDC, 220VAC European.

NOTES:
†Any module not shown with a 10V output can be specified with 10V output. Consult factory for minimum quantity and pricing details and module specifications.

‡THERMOCOUPLE ALLOY COMBINATIONS
Standards: DIN IEC 584, ANSI MC96-1-82, JIS C 1602-1981

TYPE	MATERIAL
J	Iron vs. Copper-Nickel
K	Nickel-Chromium vs. Nickel-Aluminum
T	Copper vs. Copper-Nickel
E	Nickel-Chromium vs. Copper-Nickel
R	Platinum-13% Rhodium vs. Platinum
S	Platinum-10% Rhodium vs. Platinum
B	Platinum-30% Rhodium vs.Platinum-6%Rhodium
C	Tungsten-5% Rhenium vs. Tungsten-26% Rhenium
N	Nickel-14.2% Chromium-1.4% Silicon vs. Nickel-4.4% Silicon-0.1% Magnesium

****RTD STANDARDS**

TYPE	ALPHA COEFFICIENT	DIN	JIS
100Ω Pt	0.00385	DIN 43760	JIS C 1604-1989
120Ω Ni	0.00672		
10Ω CU	0.004274		

B.4 isoLynx™ Digital I/O Backpanel

Interface:	
Field Connector	high density screw clamp, 14 AWG max
System Connector	two RJ-45 modular phone jacks
Termination Networks Factory Default	S1, sections 1-3 ON
Jumpers Factory Default	
ADDR	all set = address 0
CRST	set
Data Rate	115.2kbps maximum
Channels	Maximum 128 channels I/O
Module Type	Industry standard Opto-22 miniature style
Throughput	8 msec for 16 chs digital input or output (~2000 ch/sec) with 115.2kbps RS-232/485
Operating Temperature	-40°C to +85°C
Storage Temperature	-40°C to +85°C
Relative humidity	95%, non-condensing

B.5 SCMD Selection Guide

DIGITAL INPUT MODULES, MINIATURE

MODEL	INPUT RANGE	SUPPLY VOLTAGE
SCMD-MIAC5	90 to 140VAC/DC	5V
SCMD-MIAC5A	180 to 280VAC/DC	5V
SCMD-MIAC5E	18 to 36VAC/DC	5V
SCMD-MIAC24	90 to 140VAC/DC	24V
SCMD-MIAC24A	180 to 280VAC/DC	24V
SCMD-MIDC5	3.3 to 32VDC	5V
SCMD-MIDC5F	4.0 to 32VDC	5V
SCMD-MIDC5N	10 to 60VDC	5V
SCMD-MIDC24	3.3 to 32VDC	24V

DIGITAL OUTPUT MODULES, MINIATURE

MODEL	OUTPUT RANGE	SUPPLY VOLTAGE
SCMD-MOAC5	12 to 140VAC	5V
SCMD-MOAC5A	24 to 280VAC	5V
SCMD-MOAC24	12 to 140VAC	24V
SCMD-MOAC24A	24 to 280VAC	24V
SCMD-MODC5	3.0 to 60VDC	5V
SCMD-MODC5A	5.0 to 200VDC	5V
SCMD-MODC5ML	1.0 to 50VDC	5V
SCMD-MODC24	3.0 to 60VDC	24V

Digital Input Modules - Model No. Suffixes Identifying Optional Features

Suffix	Feature
A	High voltage versions (240VAC for AC modules).
E	Low voltage 24VAC input for AC modules.
F	Fast-switching version of DC modules.
N	Enhanced noise immunity version of DC modules.

Digital Output Modules - Model No. Suffixes Identifying Optional Features

Suffix	Feature
A	High voltage versions (240VAC for AC modules, 250VDC for DC modules).
ML	FET output version of DC module, 5.0A, 50VDC.

Appendix C - Ground Connections

C.1 AN301 SCM5B-isoLynx™ Ground Connections

Use of the ground jumper arrangement on the isoLynx Analog I/O Backpanel depends on the particular system interconnection of the backpanels and SCM5B modules. This application note details three common system interface schemes; more than these could exist.

CASE 1: Factory Configuration:

J1, J4 installed
J2, J3, R1 out

This is a general purpose configuration. Multiple analog backpanels are connected together using SIG COM.

CASE 2: Remote Digital and Analog Common Connection:

J1, J2 installed
J3, J4, R1 out

Data common and analog common are usually connected at only one point in the system. This eliminates the feared ground loop. Normally, the best single point to connect grounds is close to the ADC. This is the topology used on a standard isoLynx. However, improved noise performance may be attained for a given system by connecting these grounds remotely.

CASE 3: Pseudo Ground for Offset Adjustment:

J3, J4, R1 installed
J1, J2 out

In this case, R1 is used as a voltage dropping resistor to create the possibility of an offset voltage for the ADC system. This assumes the read select logic of the system is referenced to power common. The SCM5B modules are transformer isolated between PWR COM and I/O COM (50 volts maximum). However, RD EN\ is referenced to I/O COM. For this reason I/O COM should be within 0.2 volts of the system digital common. This 0.2 volts could be exceeded, but noise margin is reduced accordingly. R1 will allow this small offset voltage to exist. Recommended value of R1 is 100 ohms. Values up to 10K ohm may be used in quiet electromagnetic conditions.

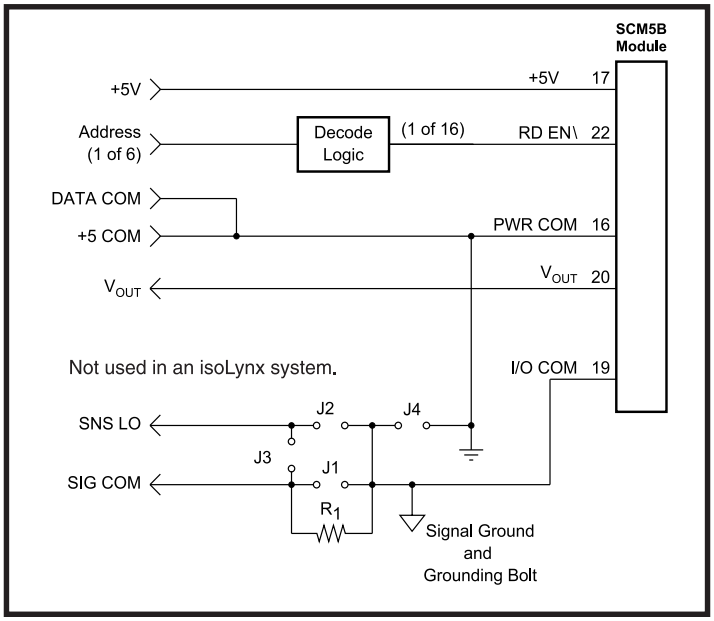

Figure C.1-1 Ground Connection Application for isoLynx Analog I/O Backpanel

C.2 AN303 SCM5B Expansion Backpanel Ground Connections

Use of the ground jumper arrangement on the SCMPB02 and SCMPB06 backpanels depends on the particular system interconnection of the backpanels and SCM5B modules. This application note details four common system interface schemes; more than these could exist.

CASE 1: Factory Configuration:

J1, J4 installed
J2, J3, R1 out

This is a general purpose configuration. Multiple analog backpanels are connected together using SIG COM.

CASE 2: Remote Digital and Analog Common Connection:

J1 installed
J2, J3, J4, R1 out

Data common and analog common are usually connected at only one point in the system. This eliminates the feared ground loop. Normally, the best single point to connect grounds is close to the ADC. In this case, J4 is removed in order to allow DATA COM and SIG COM to be connected remotely. SIG COM is connected to the ADC signal common in the isoLynx and should be connected to the SIG COM of other analog backpanels.

CASE 3: Pseudo Ground for Offset Adjustment:

J3, J4, R1 installed
J1, J2 out

In this case, R1 is used as a voltage dropping resistor to create the possibility of an offset voltage for the ADC system. This assumes the read select logic of the system is referenced to power common. The SCM5B modules are transformer isolated between PWR COM and I/O COM (50 volts maximum). However, RD EN\ is referenced to I/O COM. For this reason I/O COM should be within 0.2 volts of the system digital common. This 0.2 volts could be exceeded, but noise margin is reduced accordingly. R1 will allow this small offset voltage to exist. Recommended value of R1 is 100 ohms. Values up to 10K ohm may be used in quiet electromagnetic conditions.

CASE 4: Ground Loop Break:

J4, R1 installed
J1, J2, J3 out

In some systems, it may be desired to break the signal common ground loop of multiple backplanes with resistances. R1 may be used for this. A recommended value is 100 ohms.

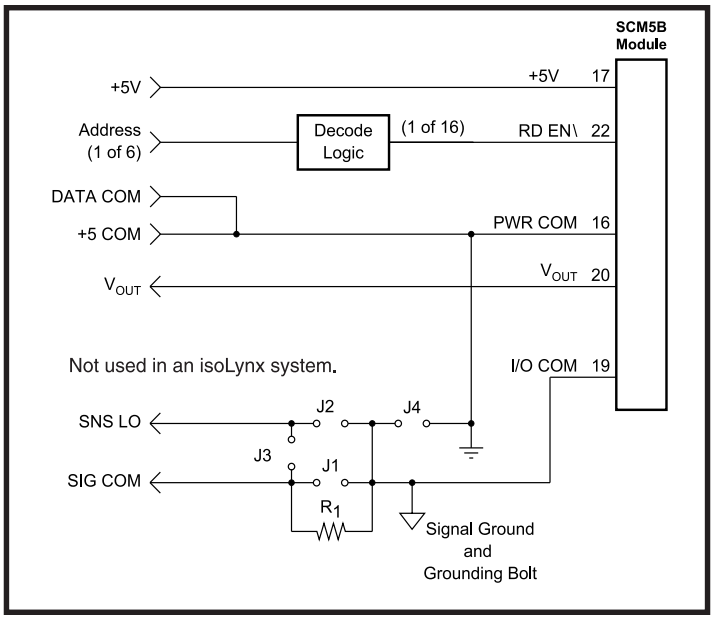

Figure C.2-1 Ground Connection Application for SCMPB02 or SCMPB06

Appendix D - AN302 isoLynx™ RS-485 and Digital I/O Expansion Network Configurations

General Notes on Termination:

For isoLynx RS-485, Digital I/O Backpanel or other RS-485 device at the extreme ends of the line:

The need for termination depends on data rate, line length, cable electrical characteristics and environment, and if applicable, the number of multidropped devices. This is best determined by switching in or out each termination network for most reliable data transfer.

For RS-485 devices other than the isoLynx RS-485 or Digital I/O Backpanel, termination networks may need to be added externally.

For TD (Transmit Data), 120Ω across the lines is standard. For RD (Receive Data), 120Ω across the lines may suffice. However, some cases may need line bias resistors as well. The line bias resistors hold the true data line (B', +, DATA) at least 0.2V more positive than the inverted data line (A', –, DATA*) in the MARK (idle) state. The network will consist of a 1.0kΩ pull-up resistor connected to +5.0V at one end to the true data line and the 120Ω resistor at the other end. Then a 1.0kΩ pull-down resistor connected to Return at one end to the inverted data line and the 120Ω resistor at the other end. If +5V and/or Return are not available externally, you may have to contact the manufacturer to find out how to access these internally. Another alternative is to install your own +5V power supply and connect its negative terminal to the RS-485 device's RS-485 Return. Also, if the RS-485 circuits are isolated, use an isolated output power supply.

For isoLynx RS-485, Digital I/O Backpanel, or other RS-485 device multidropped between the extreme ends of the line:

All terminations should be disconnected from the line.

isoLynx RS-485 or Digital I/O Expansion Network Connections, Half Duplex – 2-wire, Point-to-Point

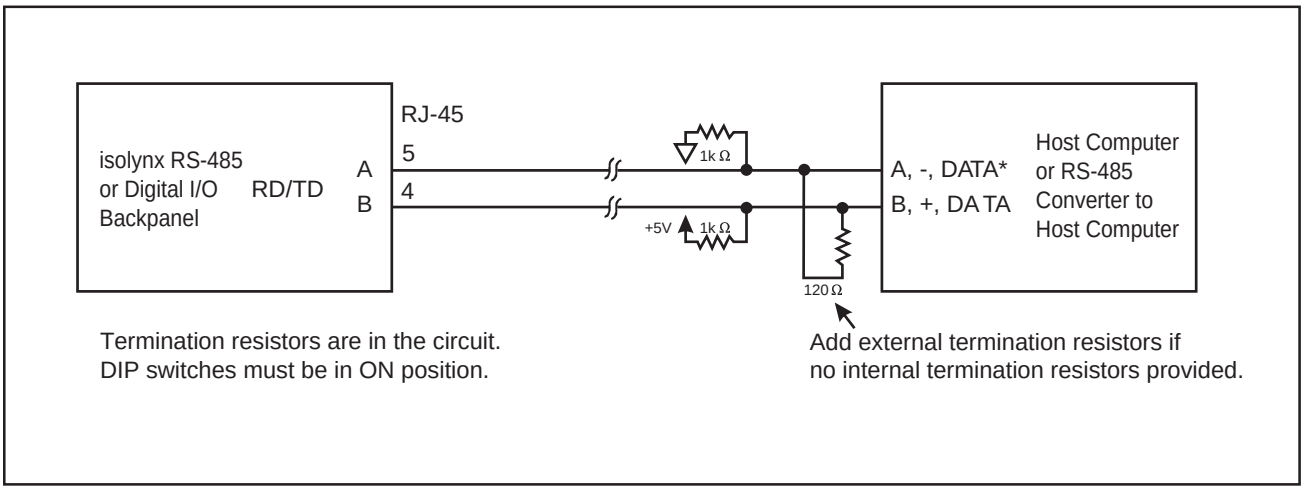

Figure D-1

isoLynx RS-485 or Digital I/O Expansion Network Connections, Half Duplex – 2-wire, Multidrop

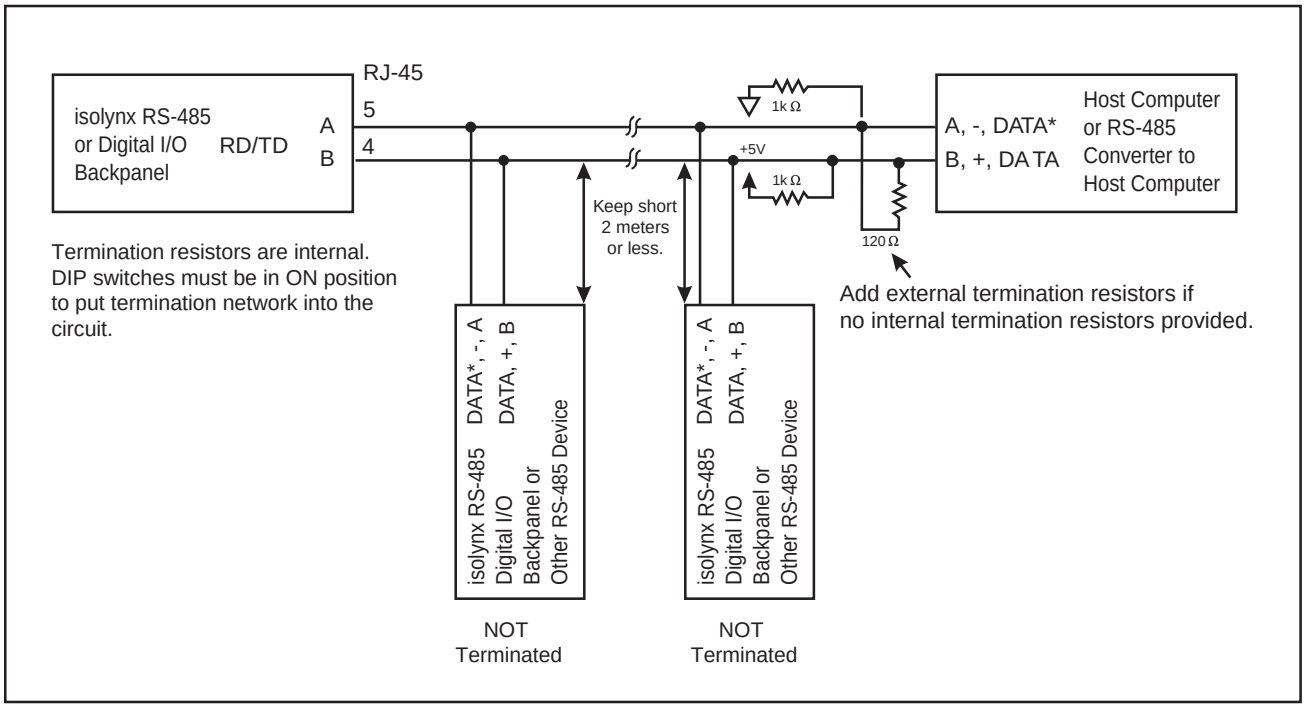

Figure D-2

isoLynx RS-485 Connections, Half Duplex – 4-wire, Point-to-Point

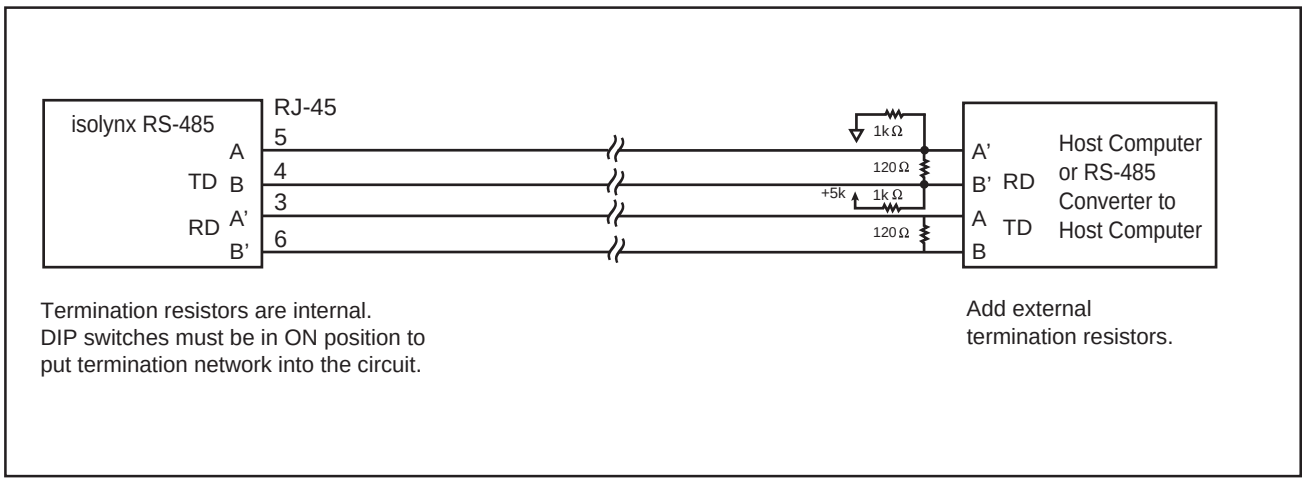

Figure D-3

isoLynx RS-485 Connections, Half Duplex – 4-wire, Multidrop

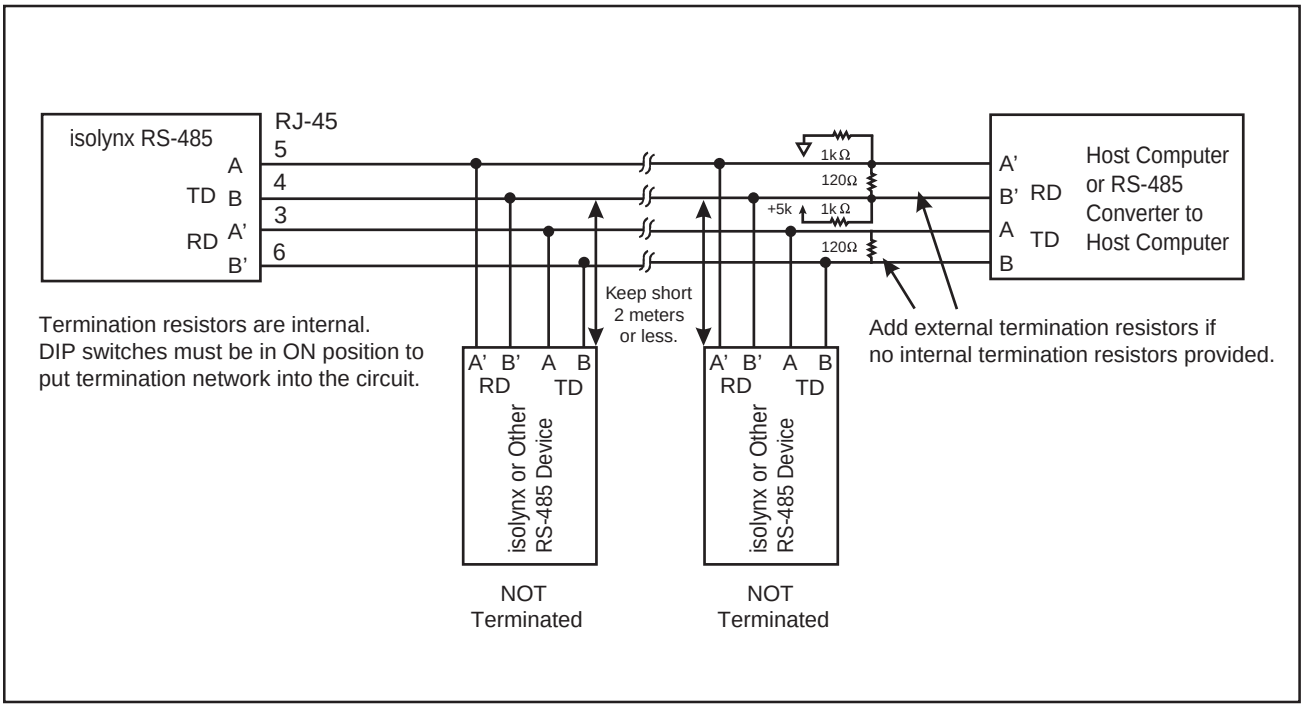

Figure D-4

Appendix E - Warranty, Disclaimers, Return/Repair Policy

WARRANTY

General. Seller warrants that its products furnished hereunder will, at the time of delivery, be free from defects in material and workmanship and will conform to Seller's applicable specifications or, if appropriate, to Buyer's specifications accepted in writing by Seller. SELLER'S OBLIGATION OR LIABILITY TO BUYER FOR PRODUCTS WHICH DO NOT CONFORM TO THE ABOVE STATED WARRANTY SHALL BE LIMITED TO SELLER, AT SELLER'S SOLE DISCRETION, EITHER REPAIRING, REPLACING, OR REFUNDING THE PURCHASE PRICE OF THE DEFECTIVE PRODUCT(S) PROVIDED THAT WRITTEN NOTICE OF SAID DEFECT IS RECEIVED BY SELLER WITHIN THE TIME PERIODS SET FORTH BELOW:

i. for all software products including licensed programs, thirty (30) days from date of initial delivery;

ii. for all hardware products including complete systems, one (1) year from date of initial delivery;

iii. for all special products, sixty (60) days from date of initial delivery; and

further, all products warranted hereunder for which Seller has received timely notice of nonconformance must be returned FOB Seller's plant within thirty (30) days after the expiration of the warranty periods set forth above.

The foregoing warranties shall not apply to any products which Seller determines have, by Buyer or otherwise, been subjected to operating and/or environmental conditions in excess of the maximum value established therefor in the applicable specifications, or any products that have been the subject of mishandling, misuse, misapplication, neglect, improper testing, repair, alteration or damage.

Limitation. THE PROVISIONS OF THE FOREGOING WARRANTIES EXTEND TO BUYER ONLY AND NOT TO BUYER'S CUSTOMERS OR USERS OF BUYER'S PRODUCTS AND ARE IN LIEU OF ANY OTHER WARRANTY, WHETHER EXPRESS, IMPLIED OR STATUTORY, INCLUDING ANY IMPLIED WARRANTY OF MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE. IN NO EVENT SHALL SELLER BE LIABLE FOR INCIDENTAL, SPECIAL OR CONSEQUENTIAL DAMAGES. Seller's liability arising out of the production, sale or supply of products or their use or disposition, whether based upon warranty, contract, tort or otherwise, shall not exceed the actual purchase price paid by Buyer for Seller's products. Seller's liability for any claim of any kind shall in no case exceed the obligation or liability specified in this Warranty.

Technical Assistance. Seller's Warranty as hereinabove set forth shall not be enlarged, diminished or affected by, and no obligation or liability shall arise or grow out of, Seller's rendering of technical advice, facilities or service in connection with Buyer's order of the goods furnished hereunder.

Warranty Procedures. Buyer shall notify Seller of any products which it believes to be defective during the applicable warranty period and which are covered by the warranty set forth above. Buyer shall not return any products for any reason without the prior authorization of Seller and issuance of a Return Material Authorization number. After issuance of an RMA number, such products shall be promptly returned by Buyer (and in no event later than thirty (30) days after the warranty expiration date), transportation and insurance prepaid, to the Seller's designated facility for examination and testing. Seller shall either repair or replace any such products found to be so defective and promptly return such products to Buyer, transportation and insurance prepaid. Should Seller's examination and testing not disclose any defect covered by the foregoing warranty, Seller shall so advise Buyer and dispose of or return the products in accordance with Buyer's instructions and at Buyer's sole expense, and Buyer shall reimburse Seller for testing expenses incurred at Seller's then current repair rates.

Repair Warranty. Seller warrants its repair work and/or replacement parts for a period of ninety (90) days from receipt by Buyer of the repaired or replaced products or for the remainder of the warranty period for the initial delivery of such order as set forth above in paragraph a, whichever is greater.

Critical Applications. Certain applications using Seller's products may involve potential risks of death, personal injury, or severe property or environmental damage ("Critical Applications"). SELLER'S PRODUCTS ARE NOT DESIGNED, INTENDED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS, SAFETY EQUIPMENT, NUCLEAR FACILITY APPLICATIONS OR OTHER CRITICAL APPLICATIONS WHERE MALFUNCTION OF THE PRODUCT CAN BE EXPECTED TO RESULT IN PERSONAL INJURY, DEATH OR SEVERE PROPERTY DAMAGE. BUYER USES OR SELLS SUCH PRODUCTS FOR USE IN SUCH CRITICAL APPLICATIONS AT BUYER'S OWN RISK AND AGREES TO DEFEND, INDEMNIFY AND HOLD HARMLESS SELLER FROM ANY AND ALL DAMAGES, CLAIMS, SUITS OR EXPENSE RESULTING FROM SUCH USE.

Static Sensitive. Seller ships all product in anit-static packages. Seller's Warranty as hereinabove set forth shall not cover warranty repair, replacement, or refund on product or devices damaged by static due to Buyer's failure to properly ground.

Return/Repair Policy

All warranty and repair requests should be directed to the Dataforth Customer Service Department at (520) 741-1404. If a product return is required, request a Return Material Authorization (RMA) number. You should be ready to provide the following information:

1. Complete product model number.
2. Product serial number.
3. Name, address, and telephone number of person returning product.
4. Special repair instructions.
5. Purchase order number for out-of-warranty repairs.

The product should be carefully packaged, making sure the RMA number appears on the outside of the package, and ship prepaid to:

Dataforth Corporation
3331 E. Hemisphere Loop
Tucson, AZ 85706 USA

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